

Artificial Intelligence and Machine Learning for RF and Microwave Design:

practical technologies for present and future applications

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Outline

- **Introduction to AI, ML and ANN**
- **ANN for electronic device modeling**
- **ANN for electronic behavioral modeling**
- **Summary**

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AI and ML

AI

ML

Supervised Learning

Regression

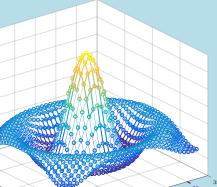
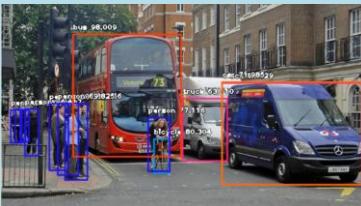
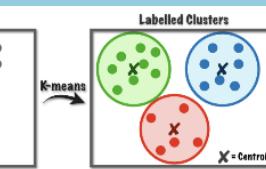
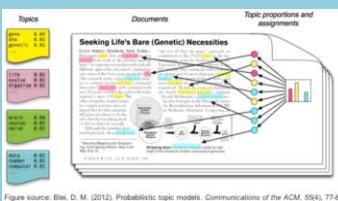


Image classification



Face recognition
Speech to text
Text translation

Unsupervised Learning



Topic Modeling

Clustering

Reinforcement Learning



Video games



Alpha Go



Stock trading



Self-driving cars



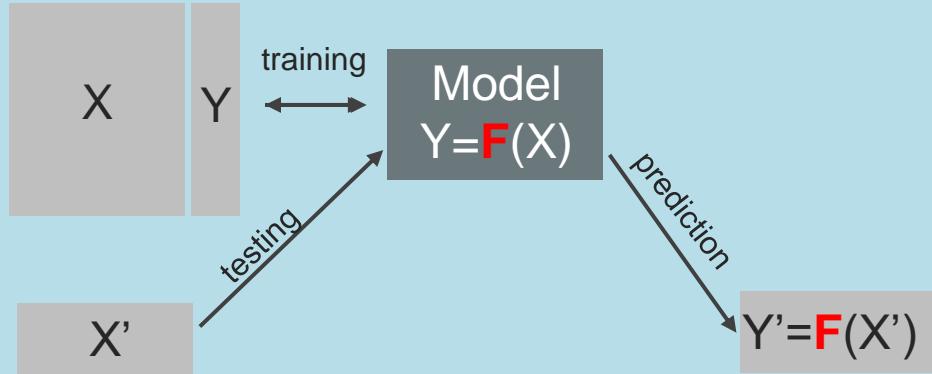
Walking, jumping, etc.

AI and ML

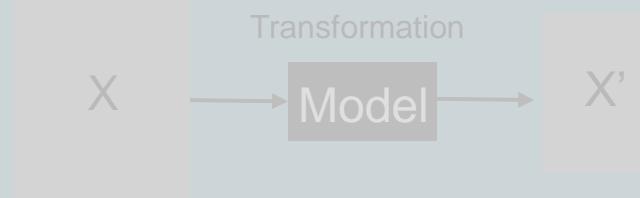
AI

ML

Supervised Learning

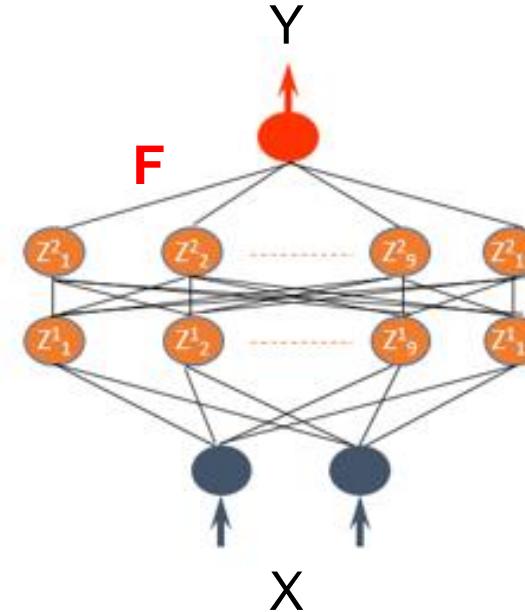


Unsupervised Learning

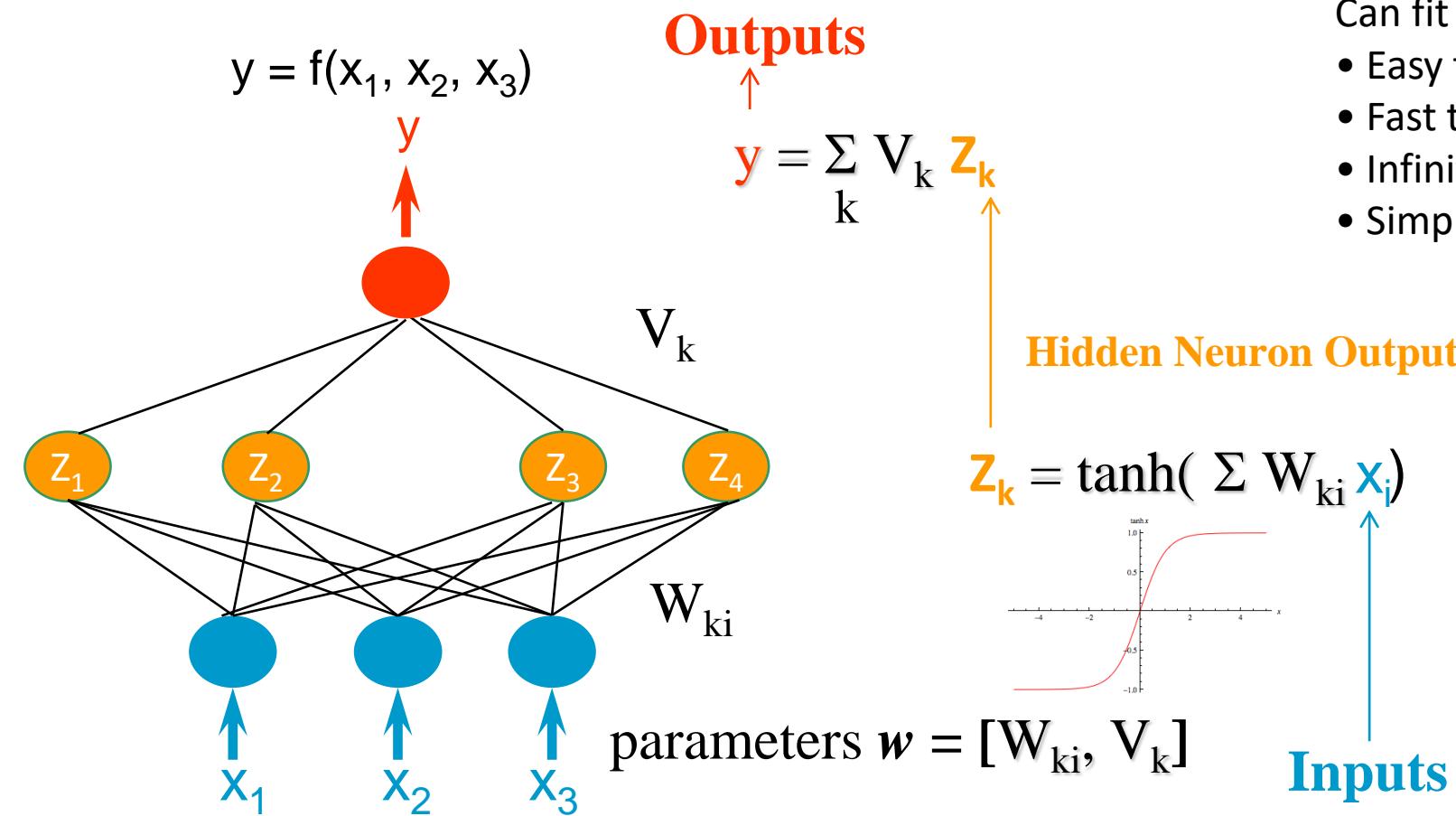


Reinforcement Learning

Artificial Neural Networks (ANN)



Introduction to Artificial Neural Networks (ANN)

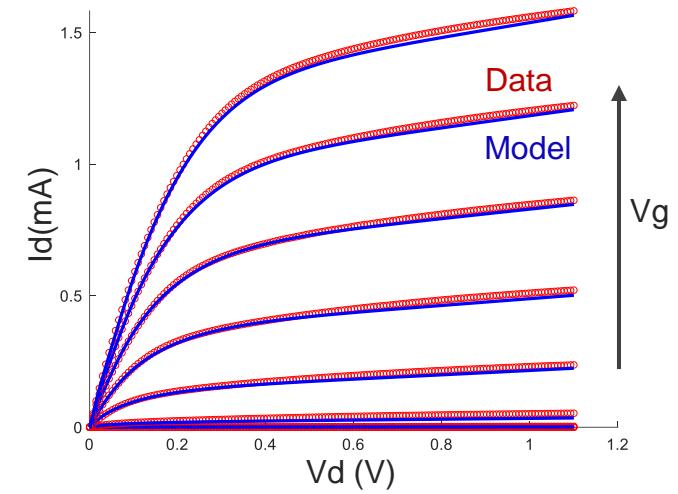
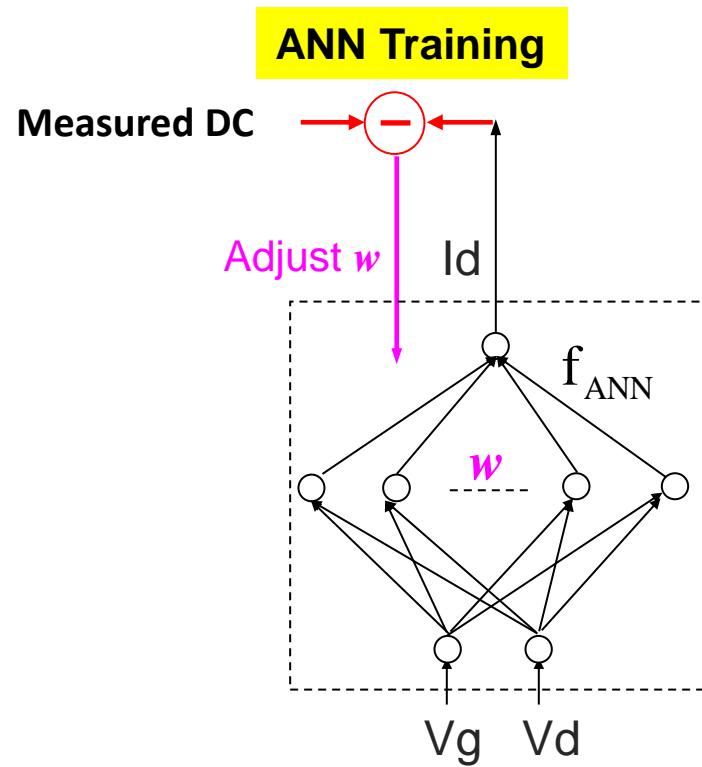
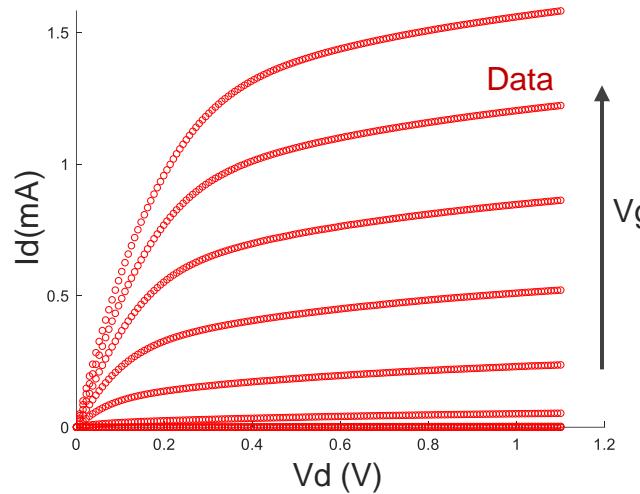


Universal approximation Theorem:

Can fit any nonlinear function of many variables

- Easy to train *on scattered data*
- Fast to evaluate
- Infinitely differentiable
- Simple link (Verilog-A, ONNX, ...) to Simulators

Introduction to Artificial Neural Networks (ANN)



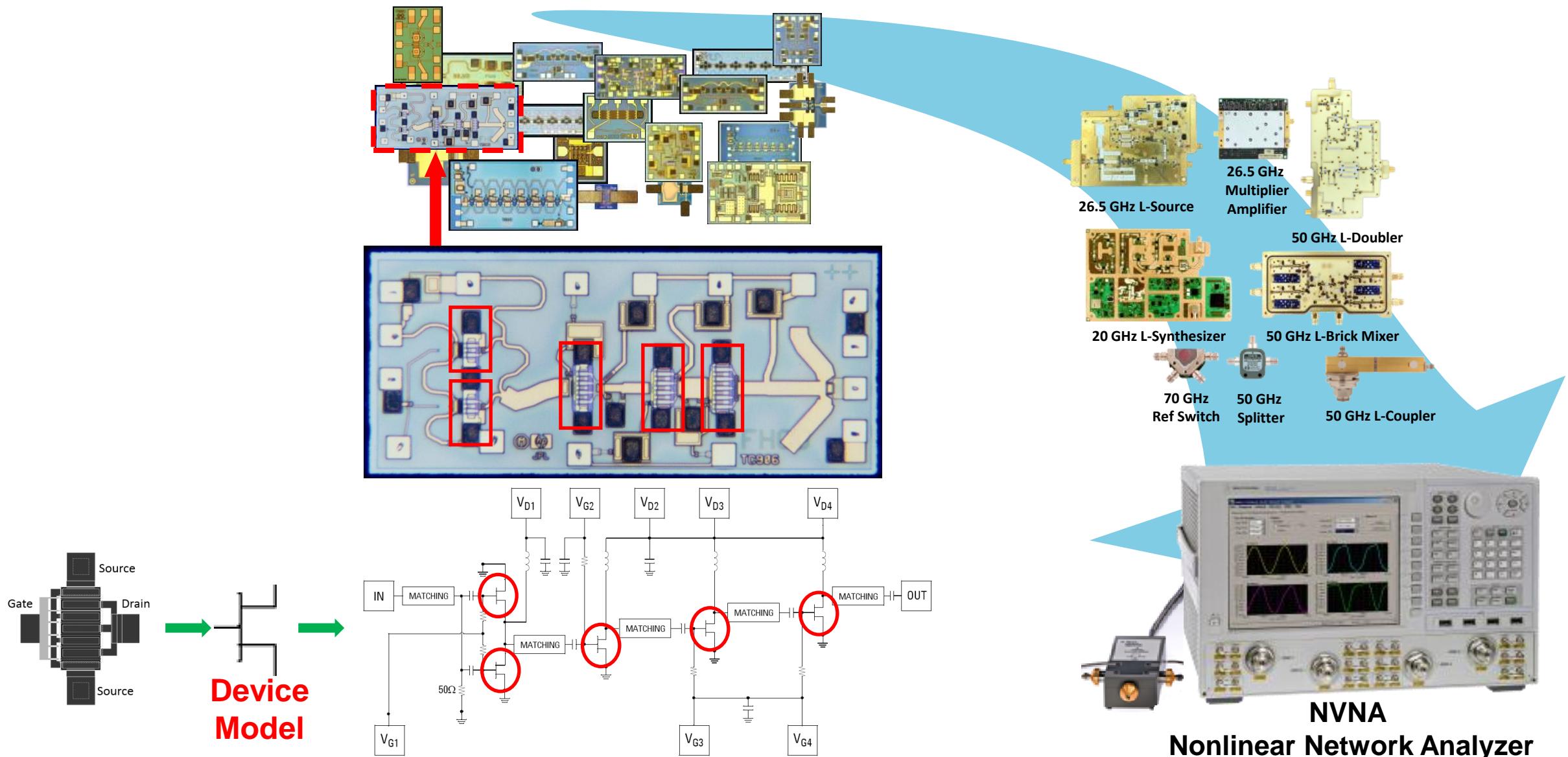
Well-known training methods (e.g. back-propagation)

- No equation development needed
- No user-defined parameter extraction strategy

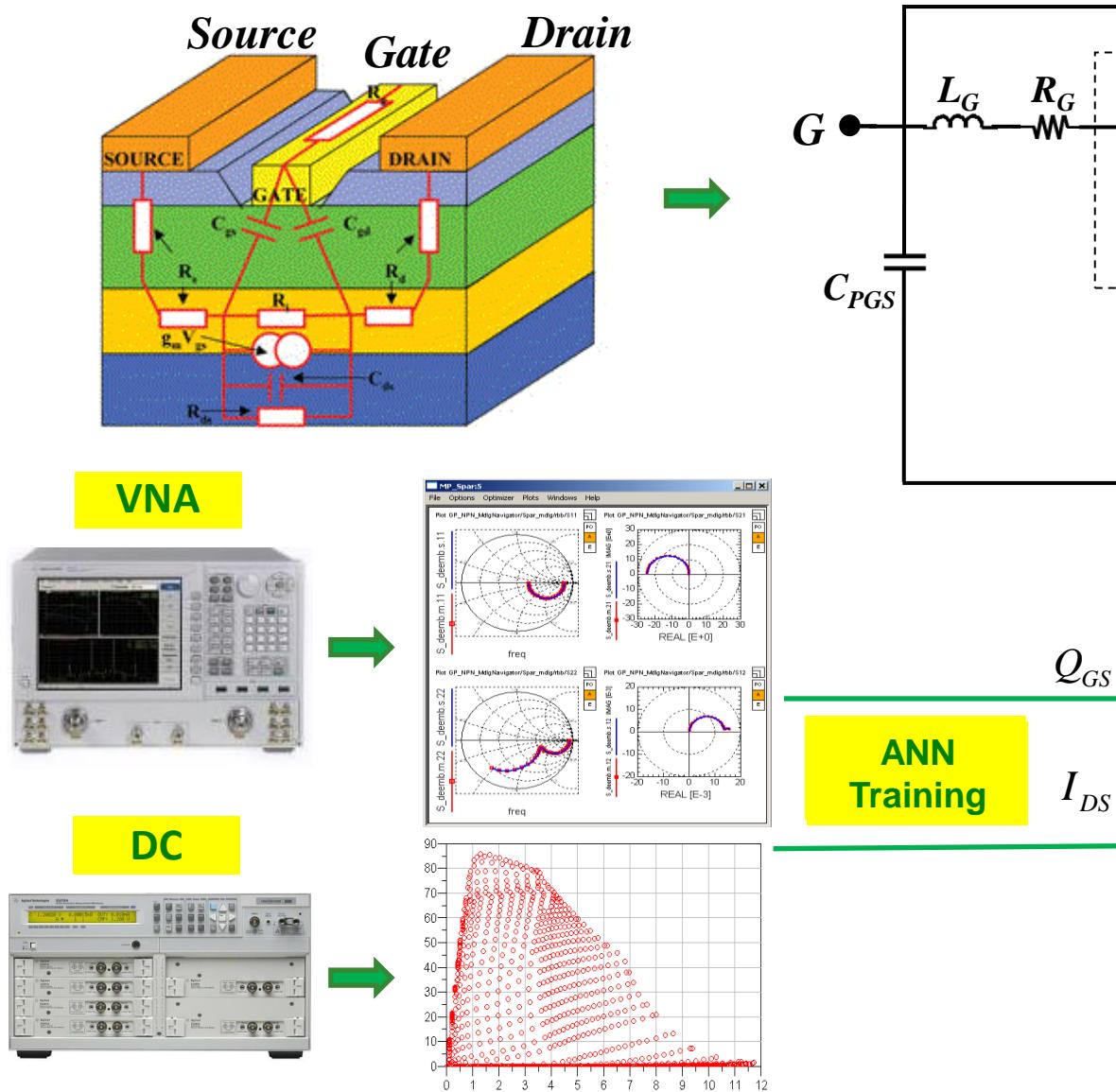
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Device Modeling



Conventional Device Modeling Flow

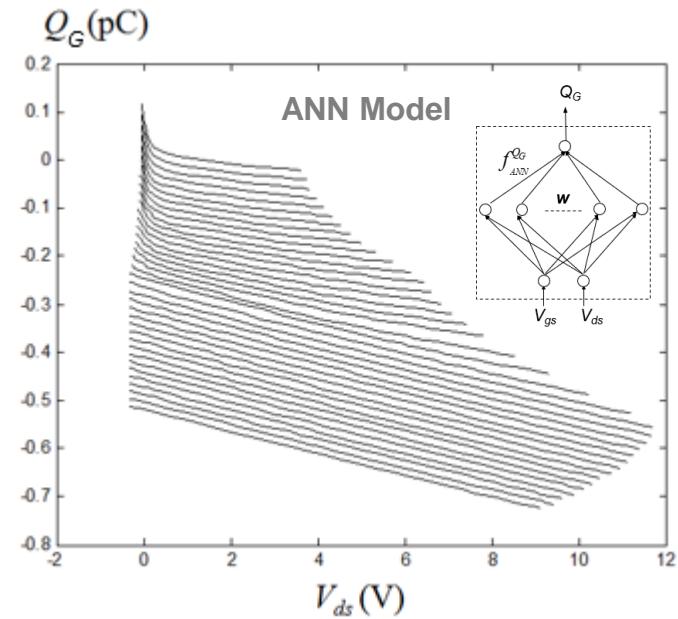
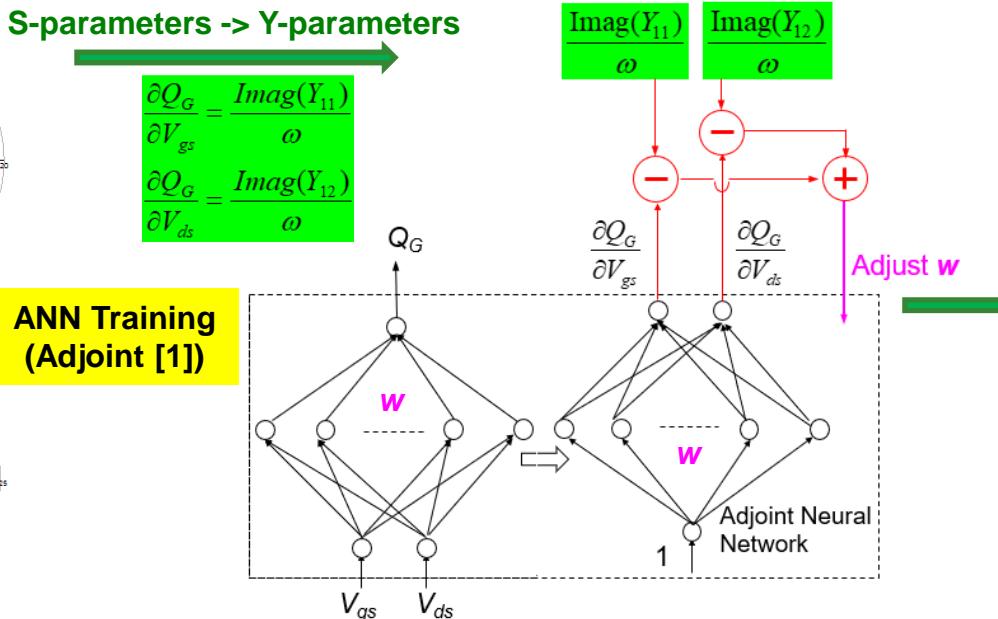
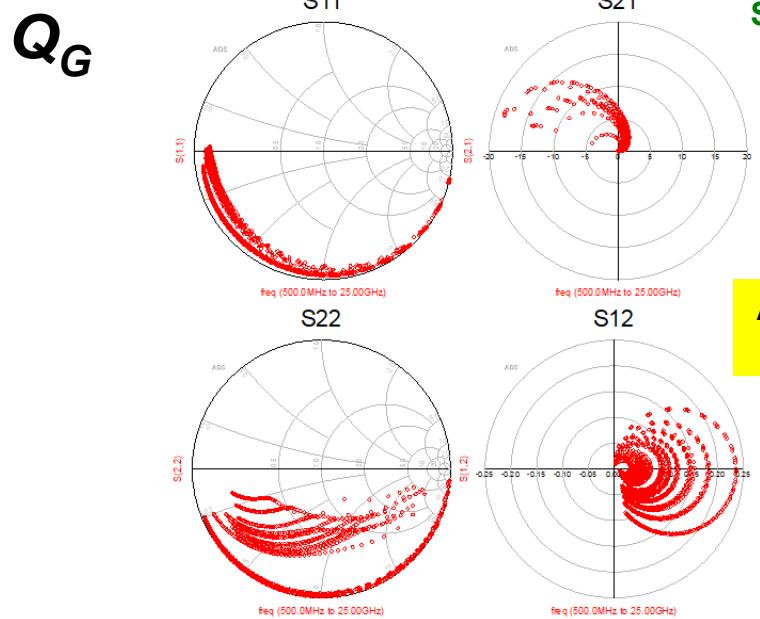
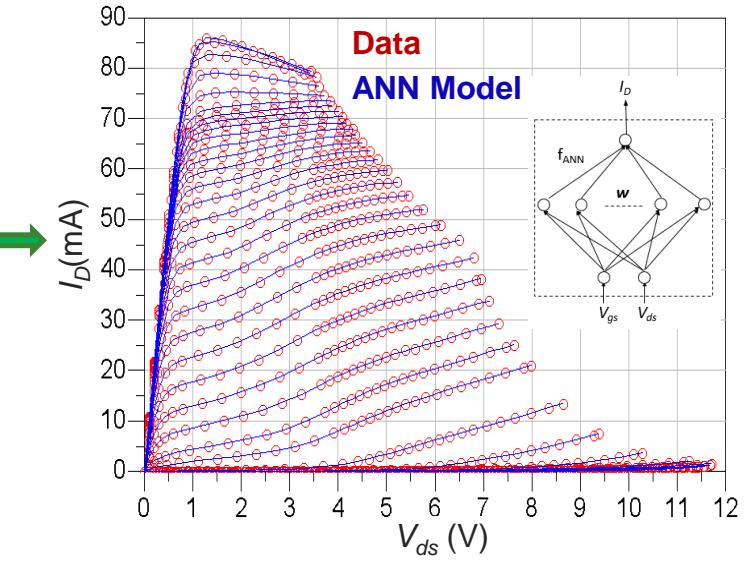
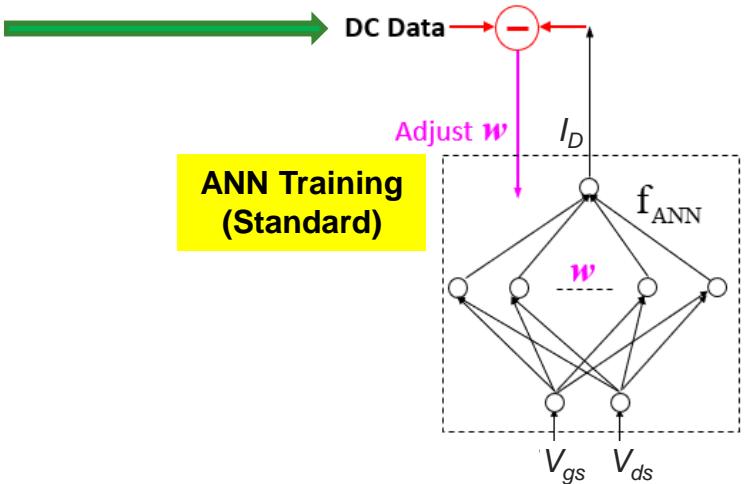
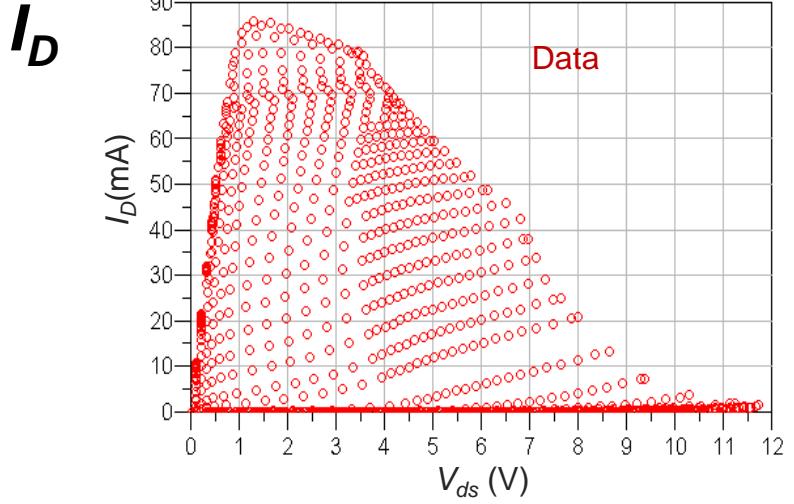


$$I_{ds} = \frac{\mu_{eff} C_g}{\sqrt{1 + \theta_{sat}^2 \psi_{ds}^2}} \frac{W}{L} (V_{go} - \psi_m + V_{th}) (\psi_{ds}) (1 + \lambda V_{ds,eff})$$

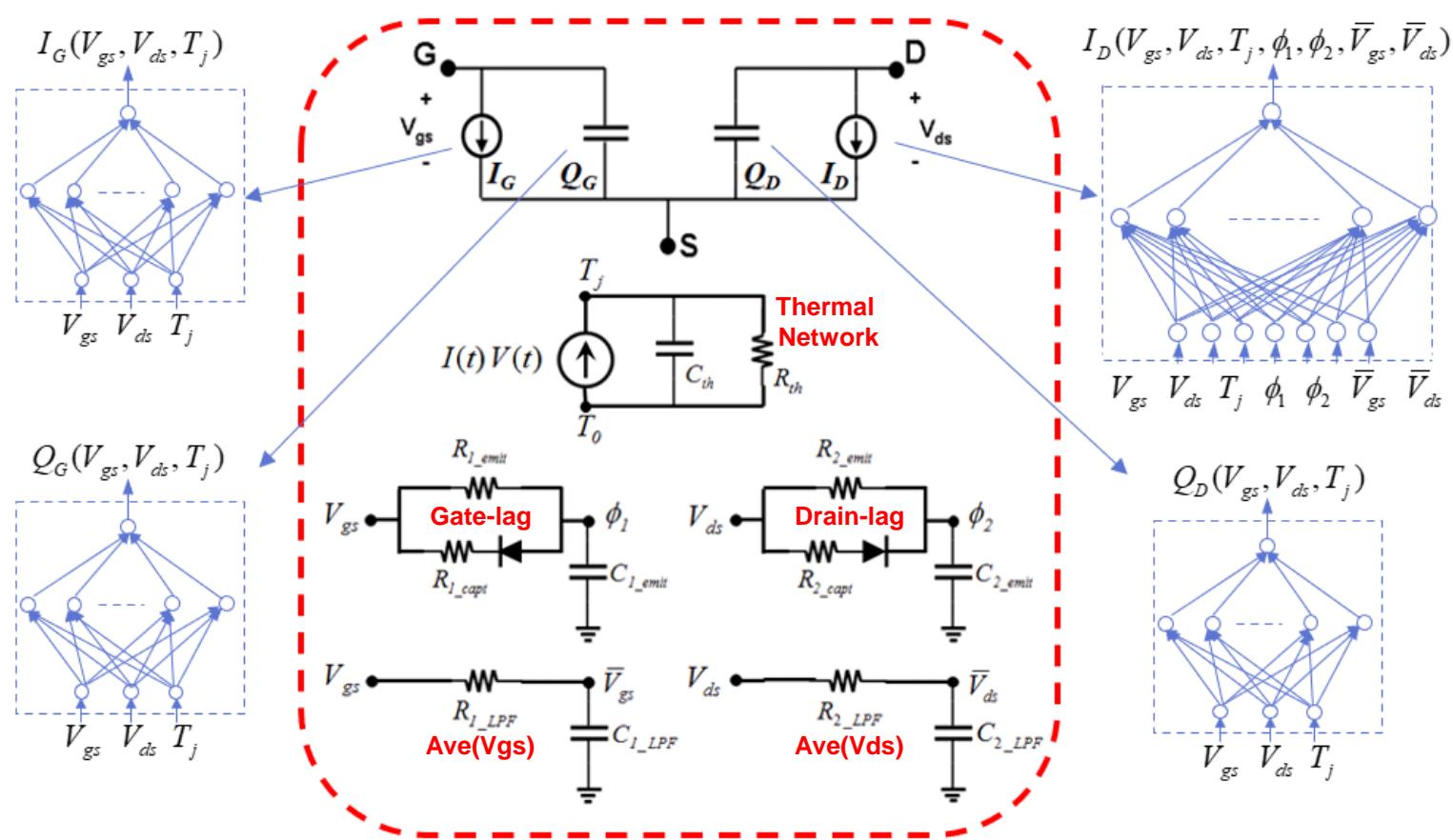
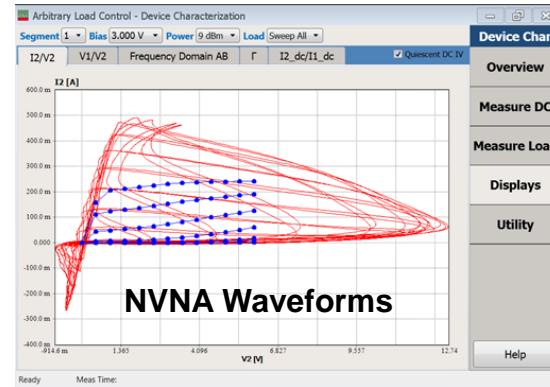
$$E_{f,unified} = V_{go} - \frac{2V_t \ln \left(1 + e^{\frac{V_{go}}{2V_t}} \right)}{\frac{1}{H(V_{go,p})} + (C_g/qD)e^{-\frac{V_{go}}{2V_t}}}$$

$$H = \frac{V_{go} + V_t [1 - \ln(\beta V_{gon})] - \frac{\gamma_0}{3} \left(\frac{C_g V_{go}}{q} \right)^{\frac{2}{3}}}{V_{go} \left(1 + \frac{V_t}{V_{god}} \right) + \frac{2\gamma_0}{3} \left(\frac{C_g V_{go}}{q} \right)^{\frac{2}{3}}}$$

ANN Training

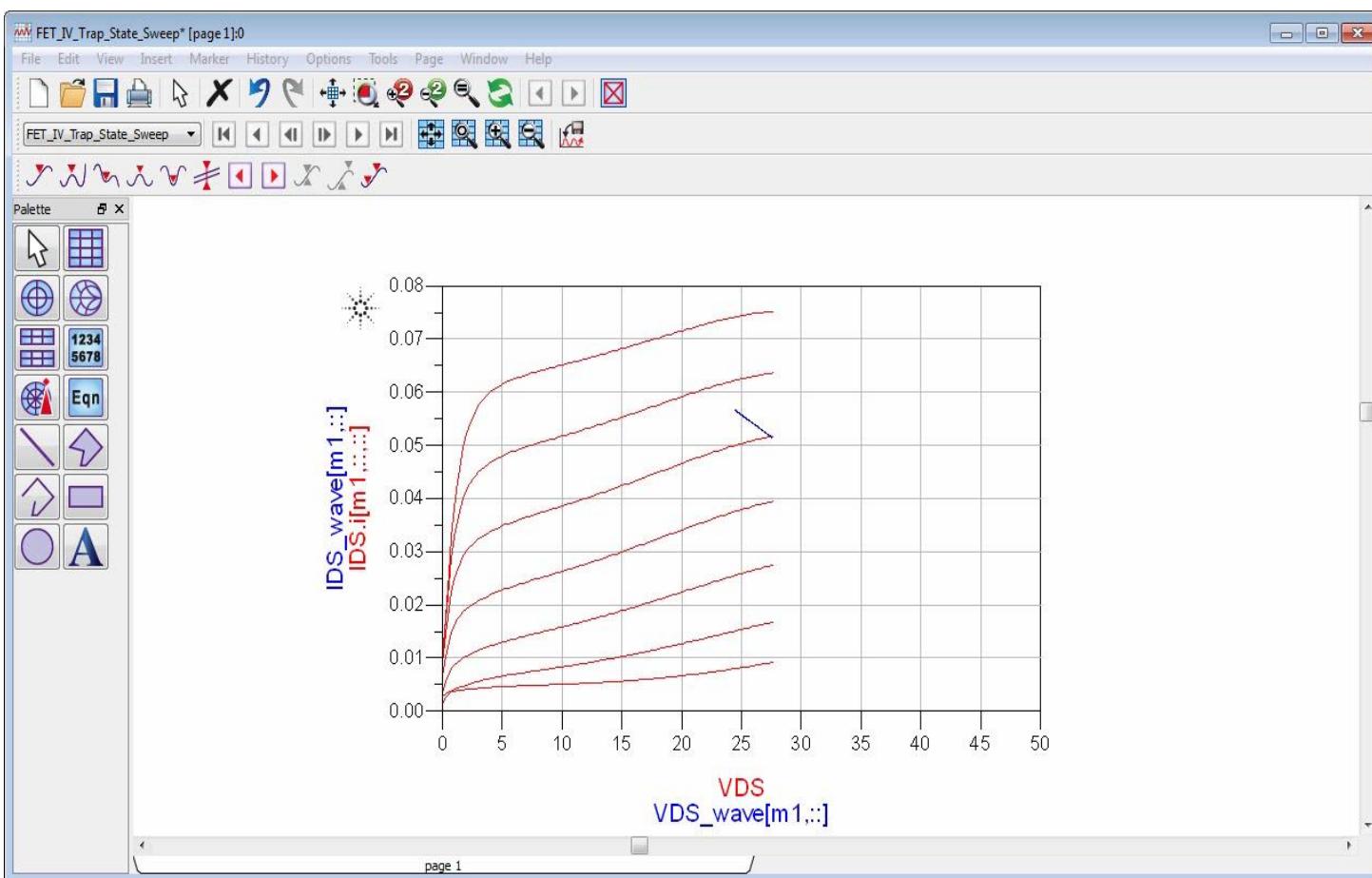


ANNs in DynaFET [2] model for GaN transistors



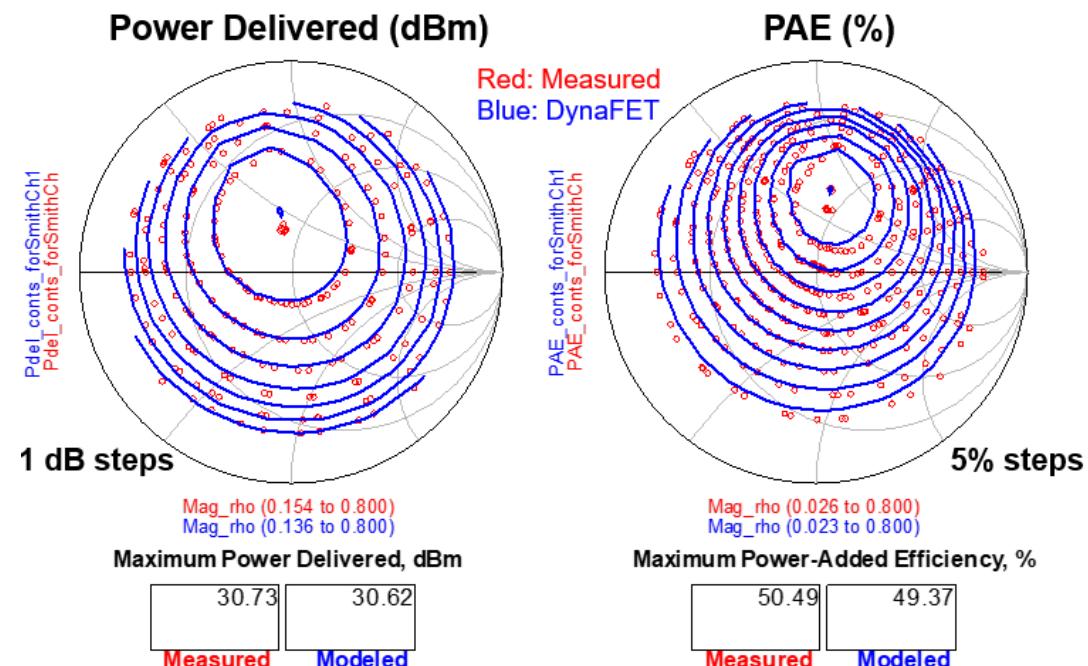
- Richer data necessary to identify complicated dynamics
- ANNs used to model the detailed, general, multi-variate coupling
 - Accurate and general
 - No additional assumptions (e.g., backgating/virtual gate)
- One global model that predicts, simultaneously:
 - DC and S-parameters
 - Large-signal nonlinearities (distortion, load-pull, PAE)
 - Long-term memory effects
 - No application-specific model tuning needed

DynaFET model for GaN transistors [2]

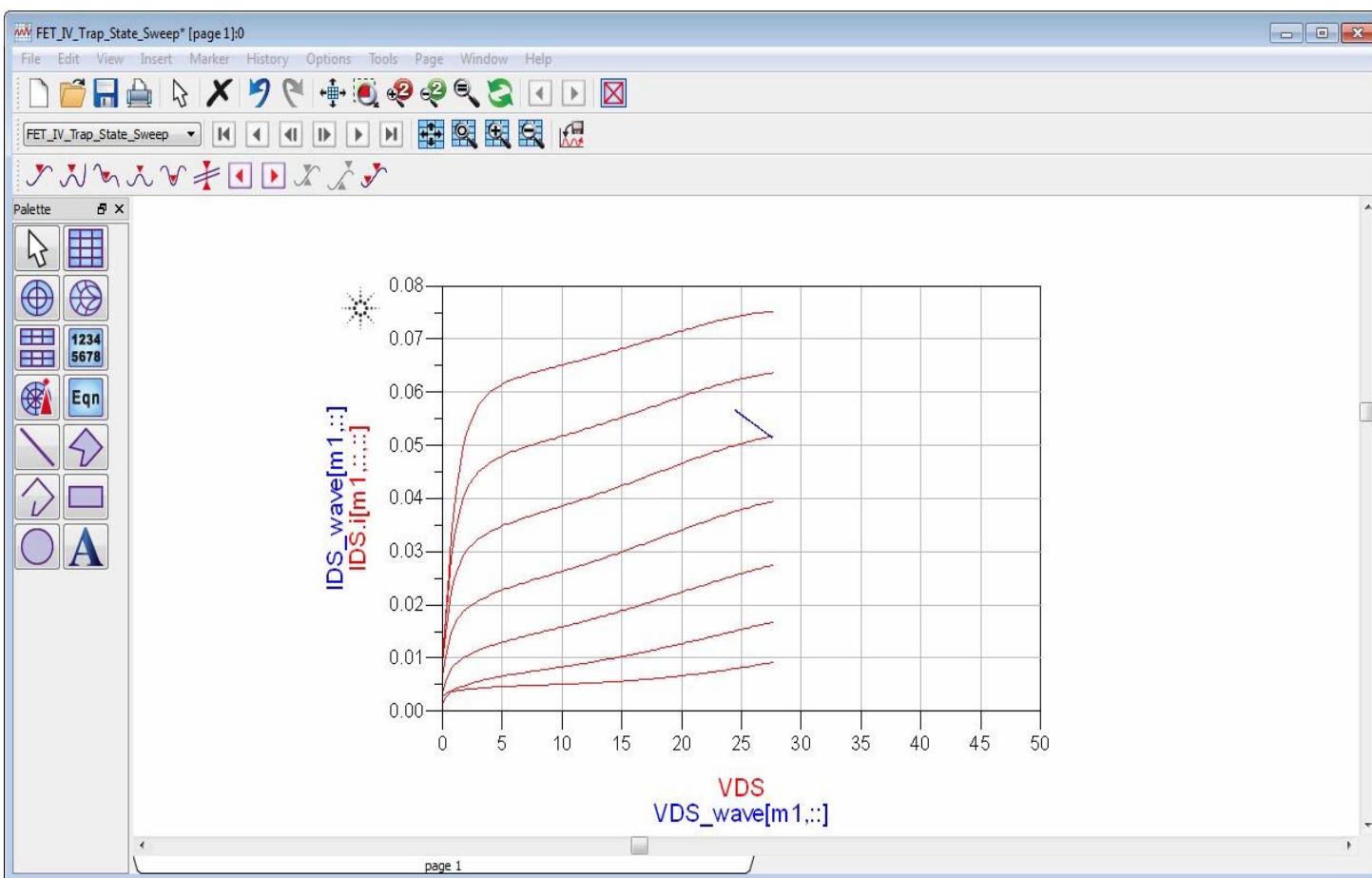


Raytheon 6x60 μ m GaN HFET

Model Validations – Load-pull Contours
fund=10GHz, @Vd=12V, Id=54mA, Pin=24dBm



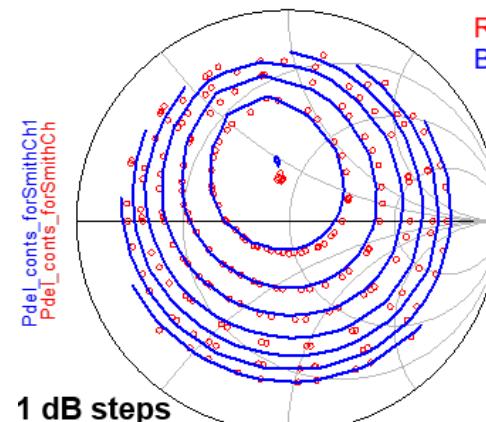
DynaFET model for GaN transistors [2]



Raytheon 6x60 μ m GaN HFET

Model Validations – Load-pull Contours
fund=10GHz, @Vd=12V, Id=54mA, Pin=24dBm

Power Delivered (dBm)



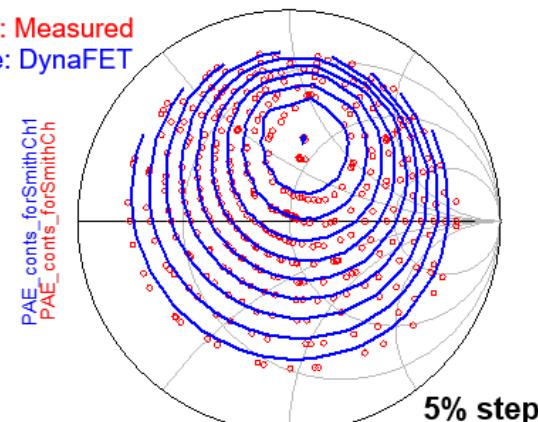
1 dB steps

Mag_rho (0.154 to 0.800)
Mag_rho (0.136 to 0.800)

Maximum Power Delivered, dBm

30.73	30.62
Measured	Modeled

PAE (%)



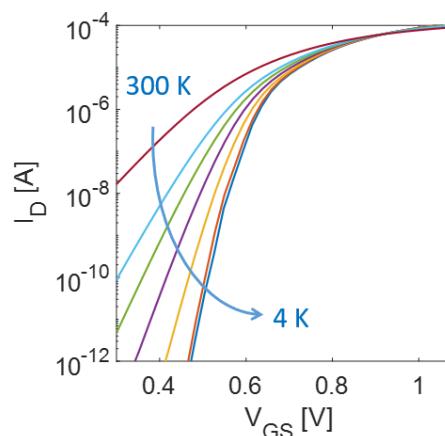
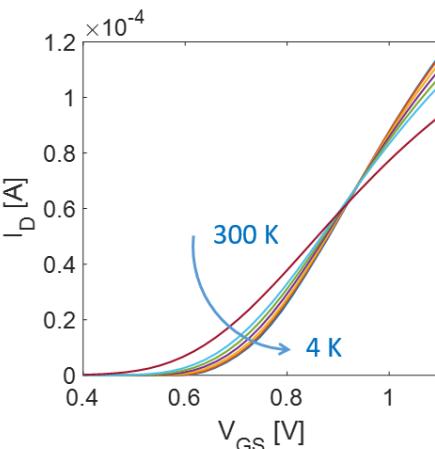
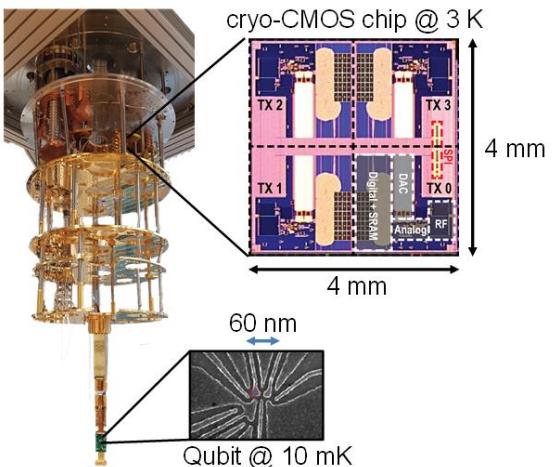
5% steps
Mag_rho (0.026 to 0.800)
Mag_rho (0.023 to 0.800)

Maximum Power-Added Efficiency, %

50.49	49.37
Measured	Modeled

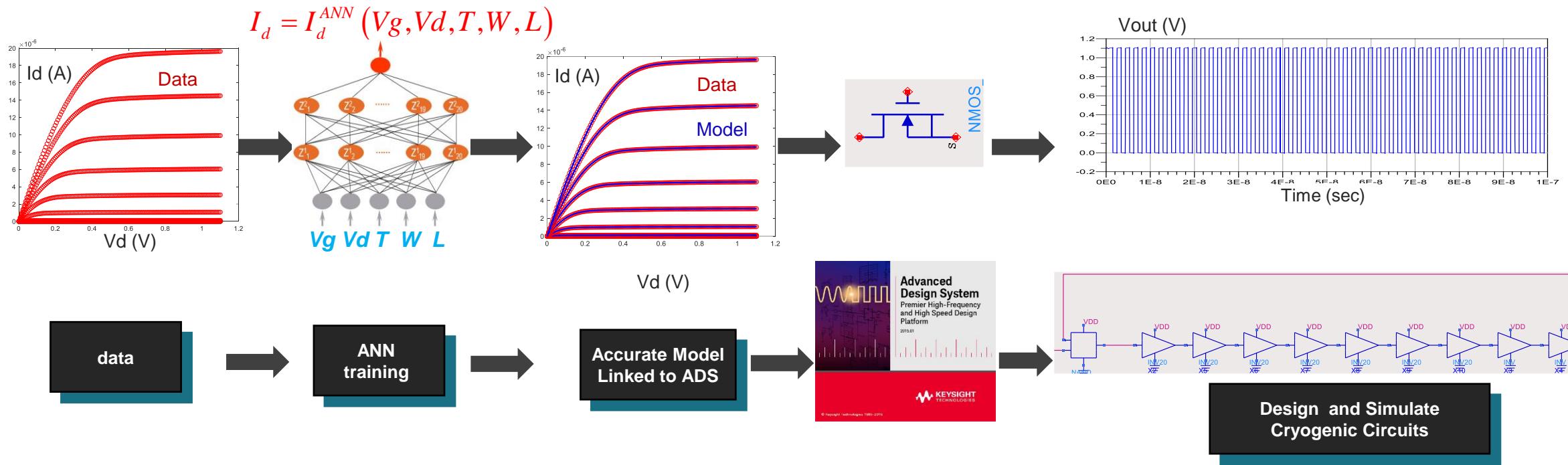
ANN for Cryogenic CMOS Modeling [3]

Enabling circuit simulations for quantum control applications



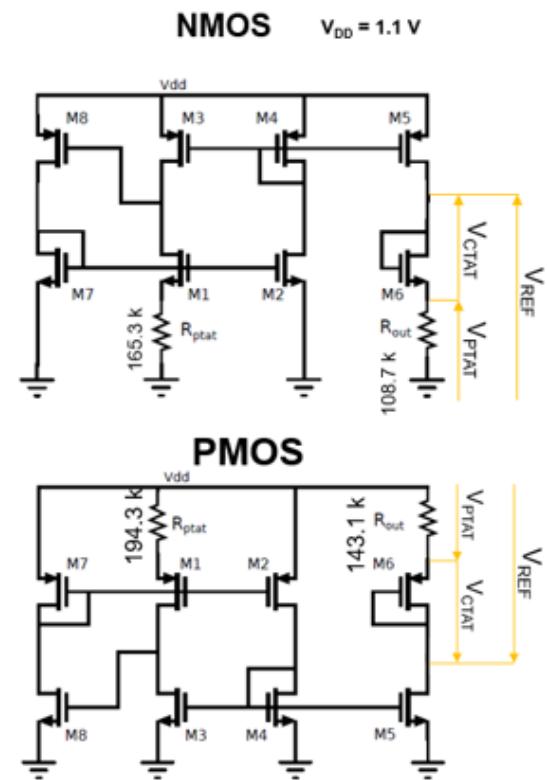
- Device characteristics at cryogenic temperatures are different from those at room temperature
- Existing models and extraction procedures may not be effective
- So far, there is not yet consensus on a standard cryo-CMOS model

Cryo Work Flow

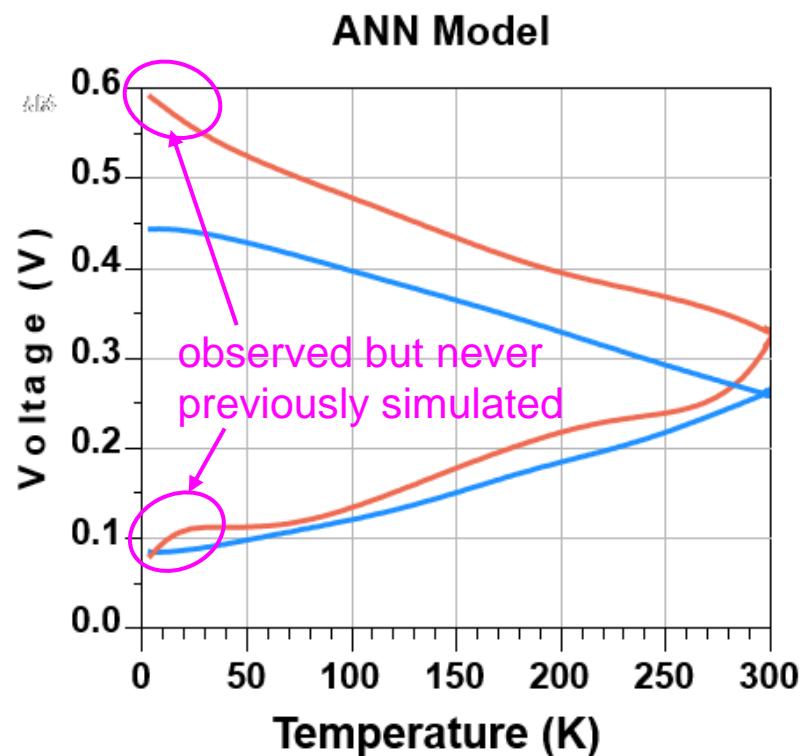
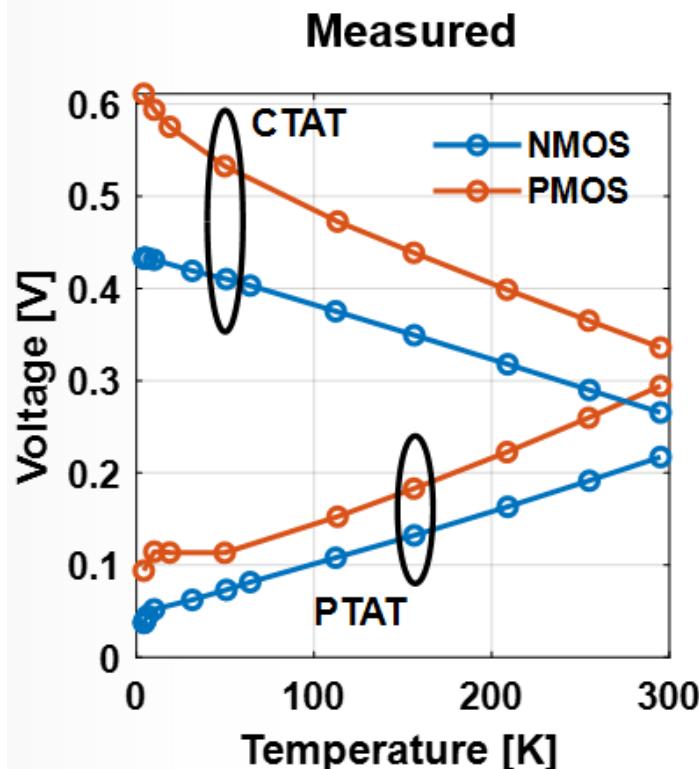
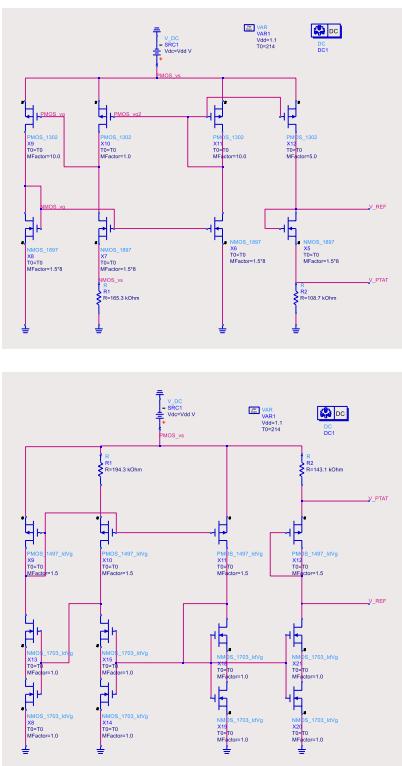


ANN for Cryogenic CMOS Modeling [3]

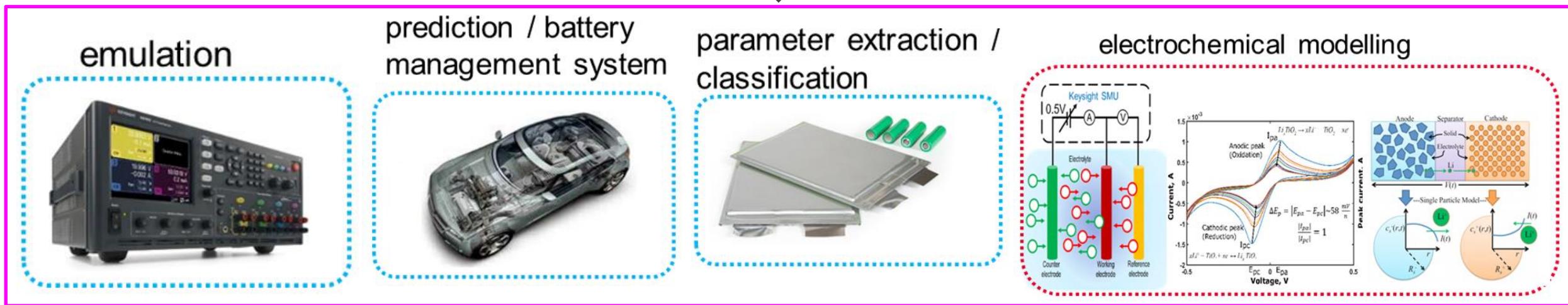
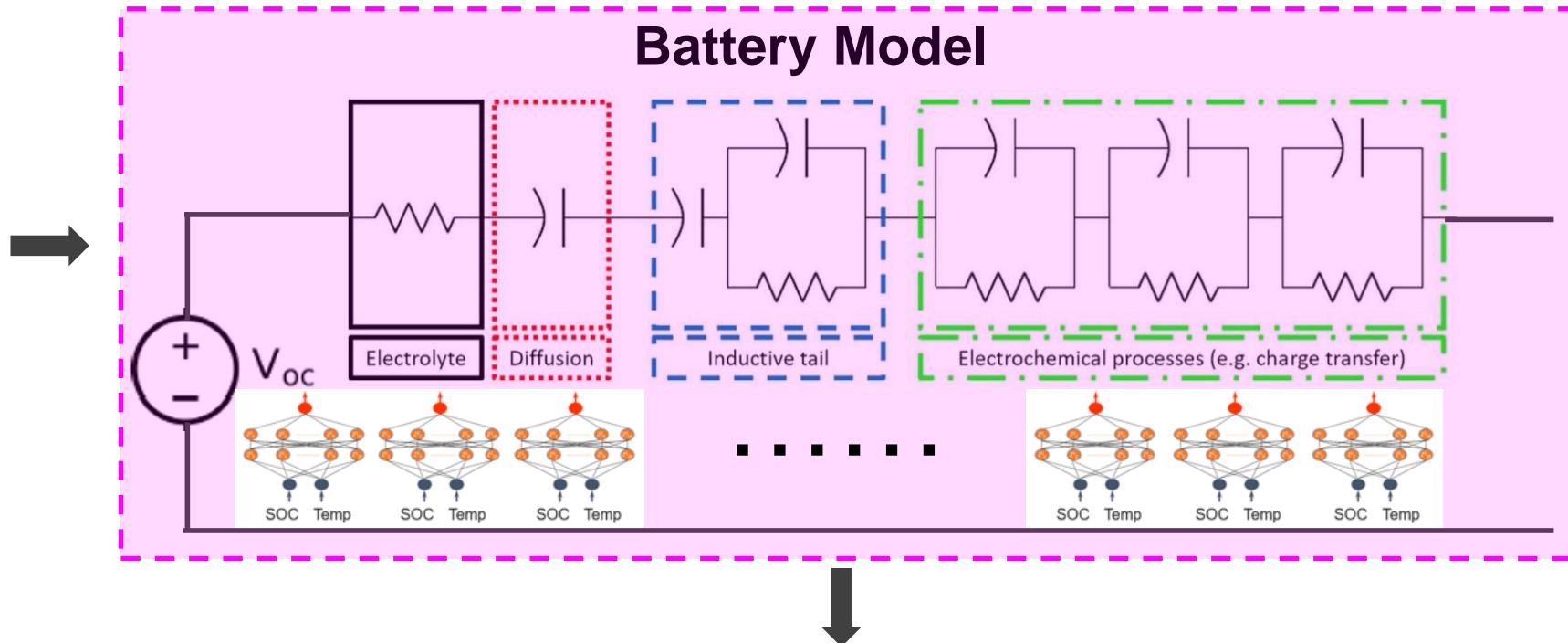
Voltage Reference Circuits



Keysight ADS
implementation with
ANN models

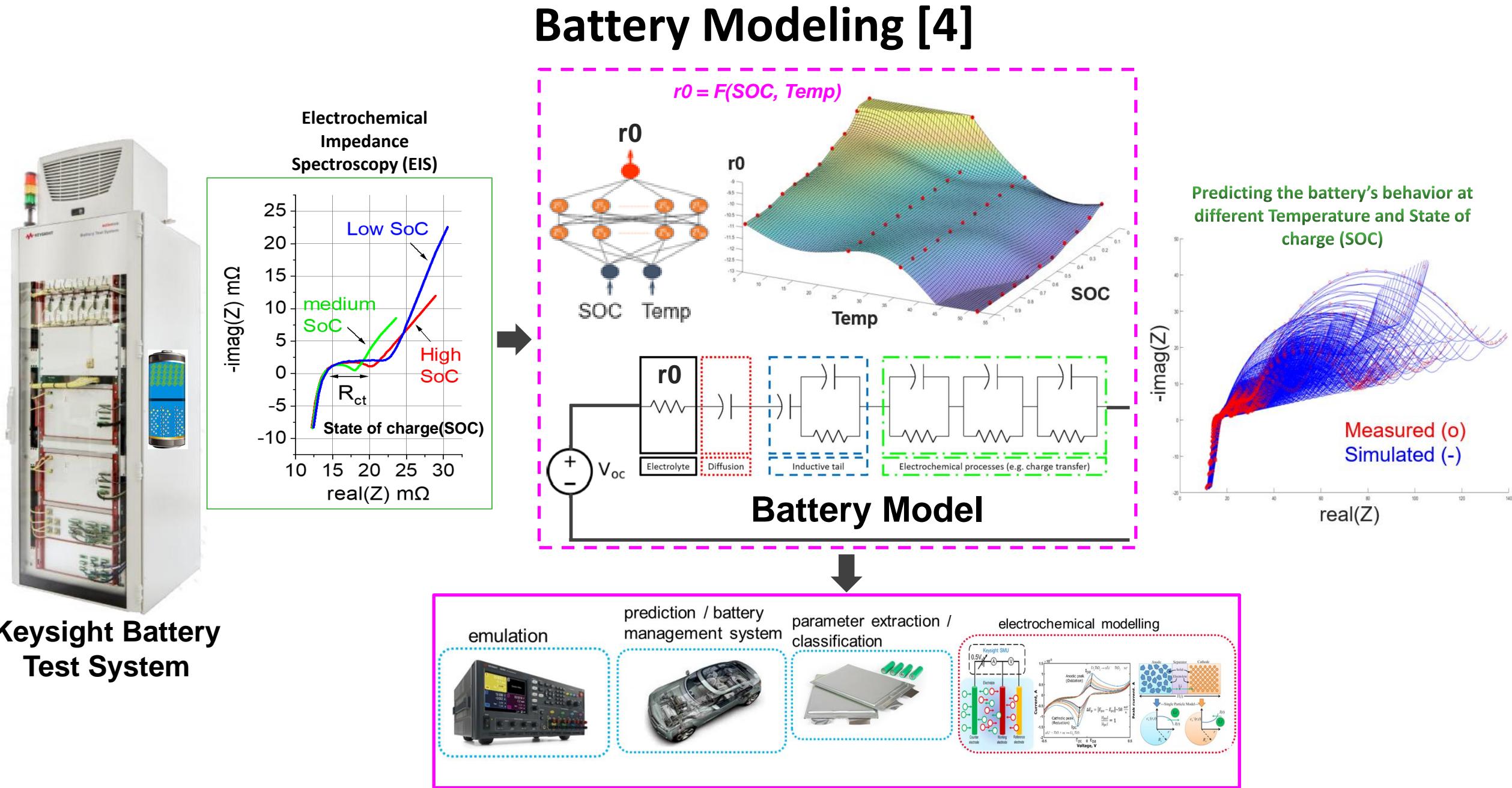


Battery Modeling [4]



[4] M. Kasper et al, "Calibrated Electrochemical Impedance Spectroscopy and Time-Domain Measurements of a 7 kWh Automotive Lithium-Ion Battery Module with 396 Cylindrical Cells", *Batteries & Supercaps* published by Wiley-VCH GmbH, 2022.

Battery Modeling [4]

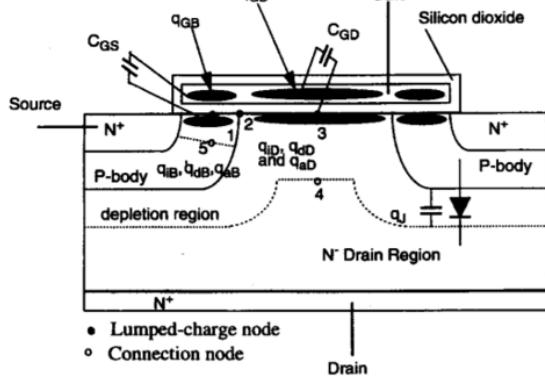


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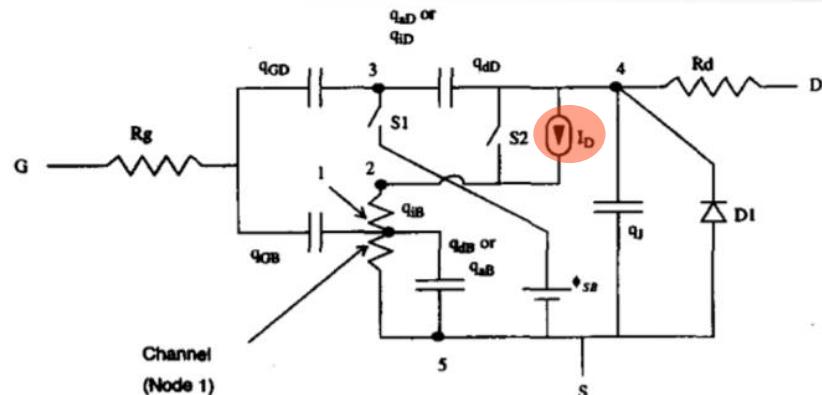
“Hybrid” physical – ANN modeling methodology [5]

- maintains physics with increased accuracy

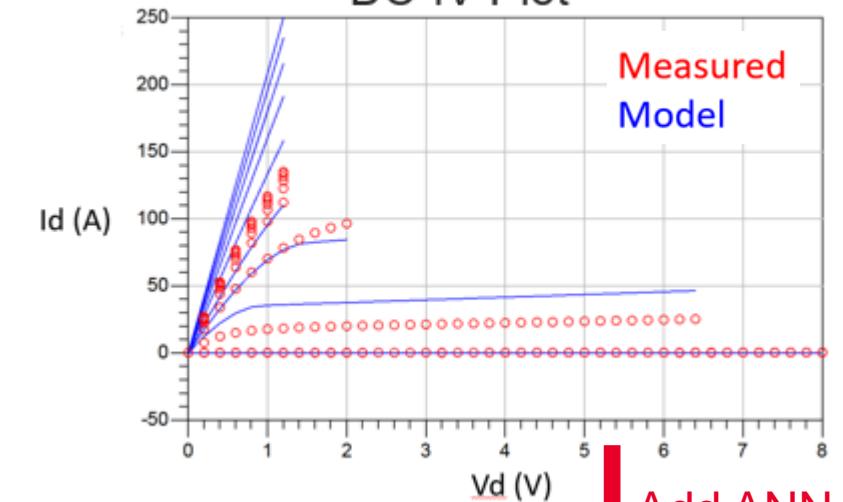
Power MOSFET



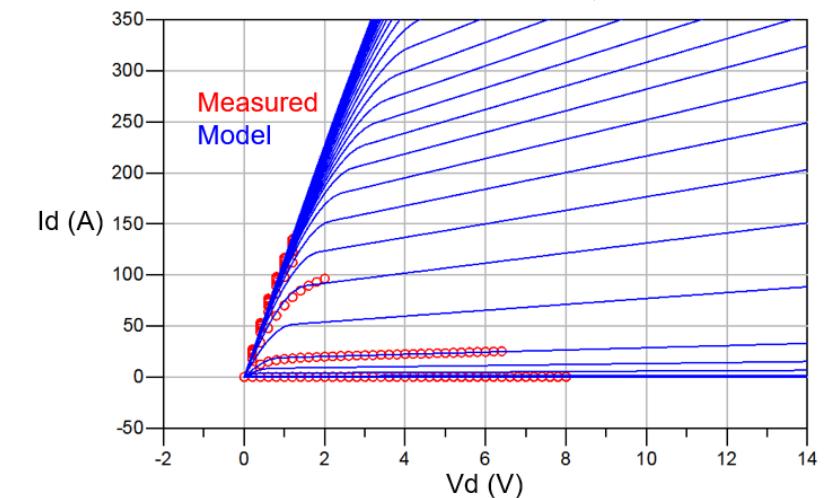
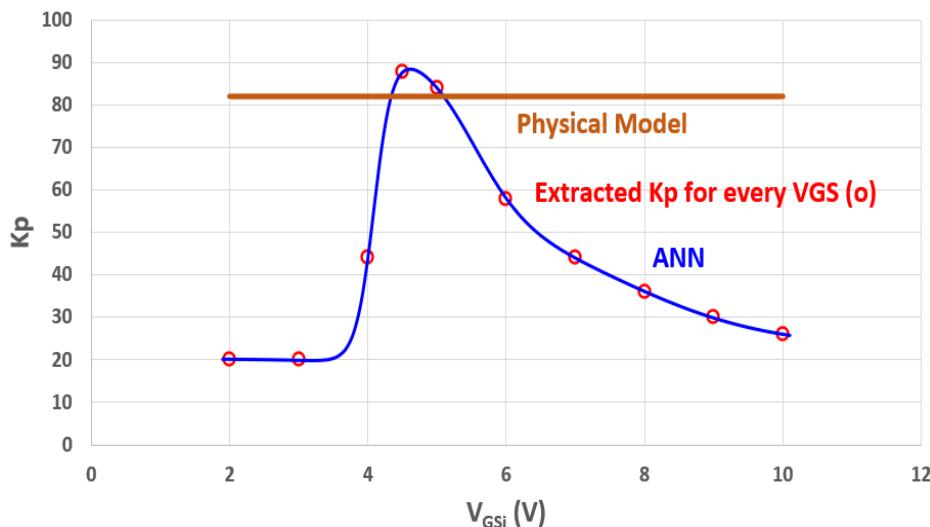
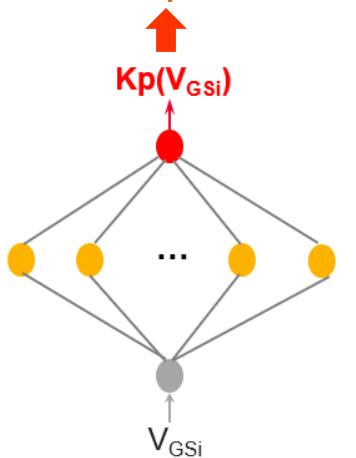
Physical Model



DC-IV Plot



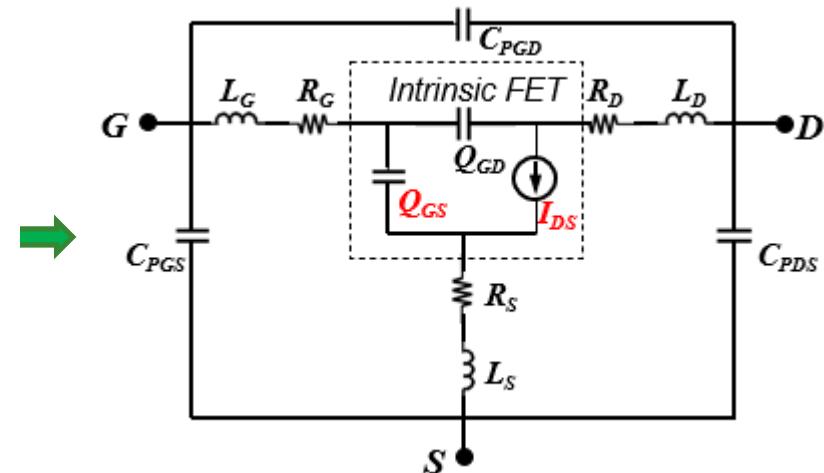
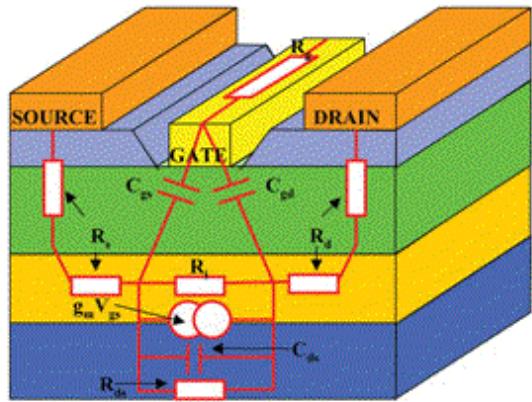
$$I_D = -\left(\frac{K_p}{((1+v_2s/V_{sat})^*(1+\theta*(V_{GSi}-VTB)))}/C_{GSon}\right)*q_iB*v_2s*(1+I_{da}*V_{DSi}) - ddt(qj) - I(s,idd)$$



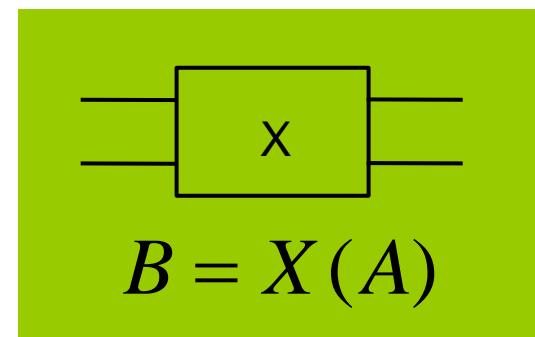
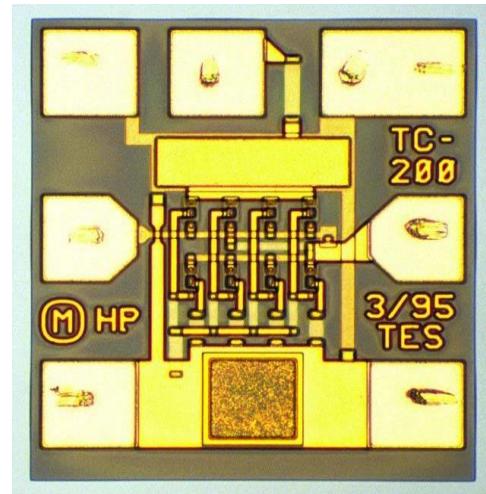
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Behavioral Modeling



Device Model

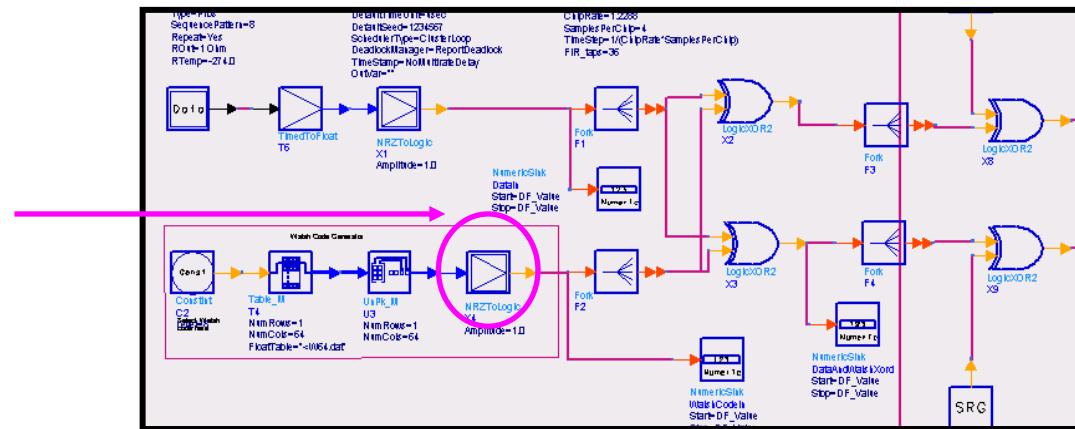


Behavioral Model

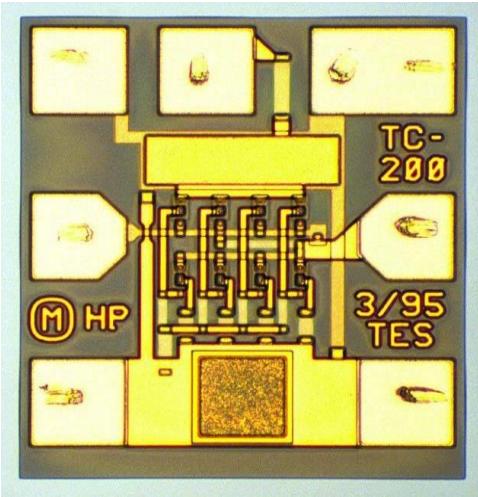
$$Q_{GS} = -C_{gs0}V_{bi} \left(1 - \frac{V_{GS}}{V_{bi}} \right)^{\eta}$$

$$I_{DS} = \left(\sum_{n=0}^3 A_n \cdot V_{GS}^n \right) \cdot \tanh(\gamma \cdot V_{DS})$$

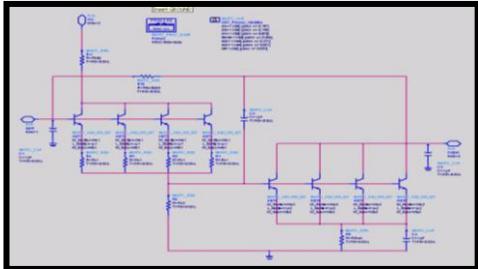
Design of Front End Module or IC



Behavioral Modeling



Actual Circuit



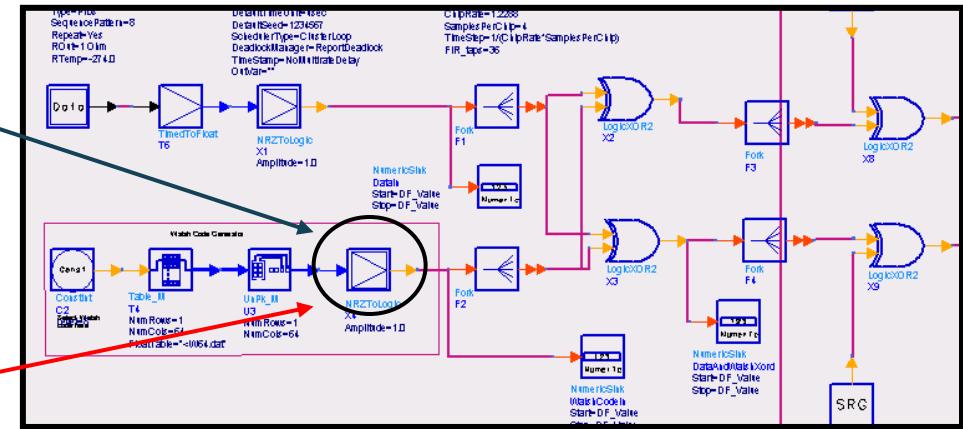
Detailed Circuit Model
(SPICE/ADS) of IC

Measurement-Based Model

- Circuit model may not exist
- Circuit models may be inaccurate
- Completely protect design IP

Generate Behavioral Model

Design of Front End Module or IC

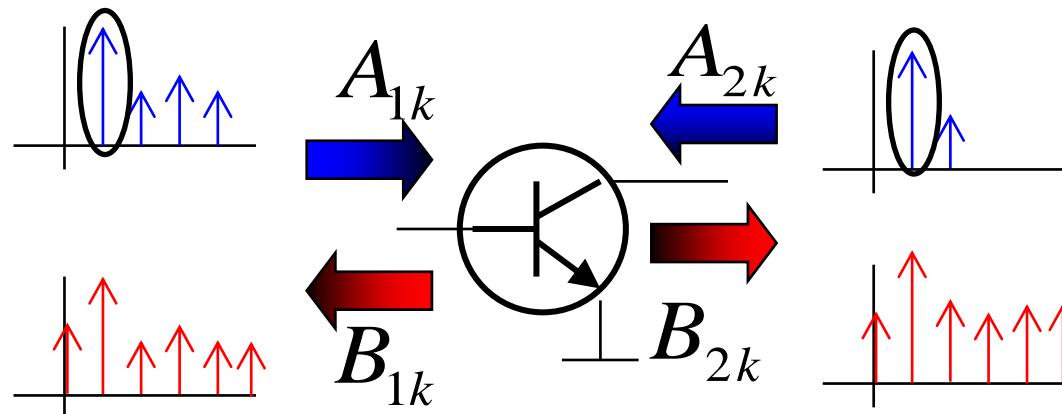


Simulation-Based Model

- Detailed circuit simulation is too slow
- Design system before building IC
- Completely protect design IP
- Do more in simulator than possible on instrument

ANN for Frequency Domain Behavioral Modeling

Load-dependent X-parameter Model [6]



$$B = X(A)$$

$$B_{p,k} \approx X_{p,k}^{(F)}(LSOP)P^k + \sum_{(q,m)>(1,1)} X_{p,k;q,m}^{(S)}(LSOP)P^{k-m}A_{q,m} + \sum_{(q,m)>(1,1)} X_{p,k;q,m}^{(T)}(LSOP)P^{k+m}A_{q,m}^*$$

- Spectral linearization around $LSOP = [Bias, Freq, |A_{1,1}|, real(A_{2,1}), imag(A_{2,1})]$
- $P = e^{j\phi(A_{11})}$ Phase of A_{11}
- Outputs assuming all harmonics are matched
- Cross-frequency mismatch sensitivity terms

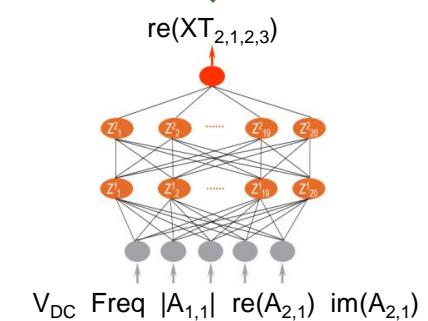
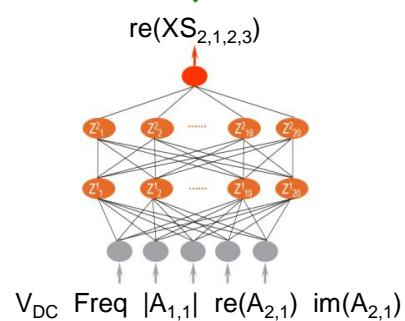
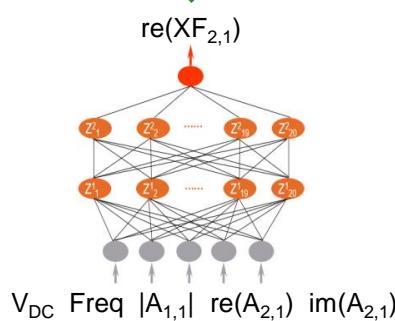
ANN for Frequency Domain Behavioral Modeling

$$B_{p,k} \cong X_{p,k}^{(F)}(LSOP)P^k + \sum_{(q,m)>(1,1)} X_{p,k;q,m}^{(S)}(LSOP)P^{k-m}A_{q,m} + \sum_{(q,m)>(1,1)} X_{p,k;q,m}^{(T)}(LSOP)P^{k+m}A_{q,m}^*$$

VDC	Freq	$ A_{1,1} $	Real($A_{2,1}$)	Imag($A_{2,1}$)	Real($XF_{2,1}$)
2.0	1e9	0.0375	0.0316	-0.123	0.0315
5.0	2e9	0.0467	0.1643	-0.588	0.1041
8.0	3e9	0.1470	0.5623	-0.963	-0.3162
...

VDC	Freq	$ A_{1,1} $	Real($A_{2,1}$)	Imag($A_{2,1}$)	Real($XS_{2,1,2,3}$)
2.0	1e9	0.0375	0.0316	-0.123	0.0015
5.0	2e9	0.0467	0.1643	-0.588	0.2102
8.0	3e9	0.1470	0.5623	-0.963	-0.1116
...

VDC	Freq	$ A_{1,1} $	Real($A_{2,1}$)	Imag($A_{2,1}$)	Real($XT_{2,1,2,3}$)
2.0	1e9	0.0375	0.0316	-0.123	-0.6031
5.0	2e9	0.0467	0.1643	-0.588	-0.5104
8.0	3e9	0.1470	0.5623	-0.963	0.2316
...



Current limitations:

- Gridded data structure forces high volume of data measurement, some conditions are hard or difficult (device damage) to measure
- Accurate simulation requires a large table of data
- Time to load data file is long and Memory usage is large
- Results may depend on particular simulator capabilities to read tables and interpolation algorithms

Benefits of replacing tables with ANNs:

- Data can be taken as needed for accuracy (e.g., adaptively) and as may be constrained by device operation
- Discrete data is converted to smooth functions for further applications downstream (optimization, system simulation, hierarchical modeling, Digital Twin)

Downside of ANNs for X-parameter modeling:

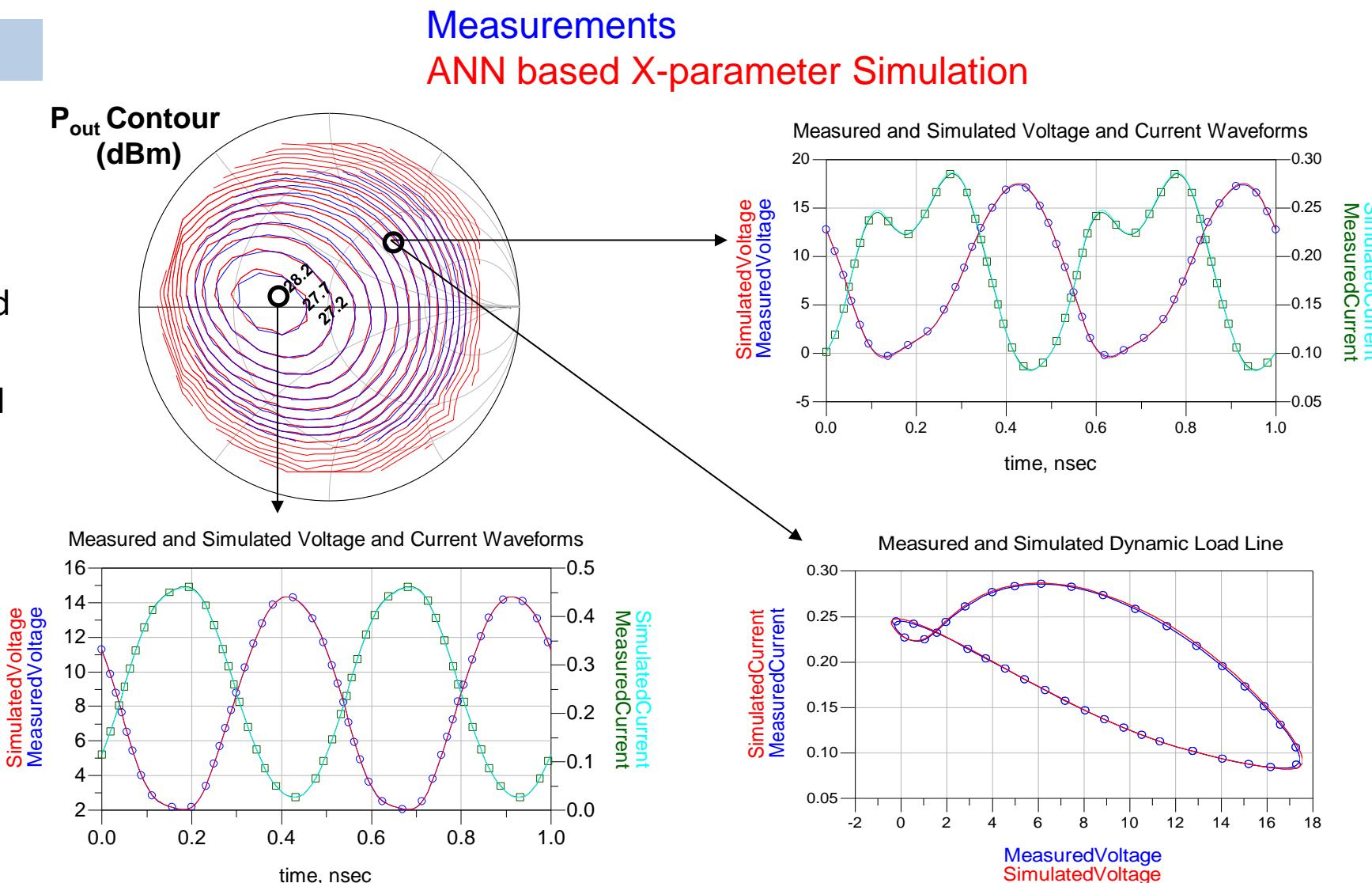
- Training times may be long, requiring parallel training infrastructure (Keysight unpublished work)

ANN for Frequency Domain Behavioral Modeling

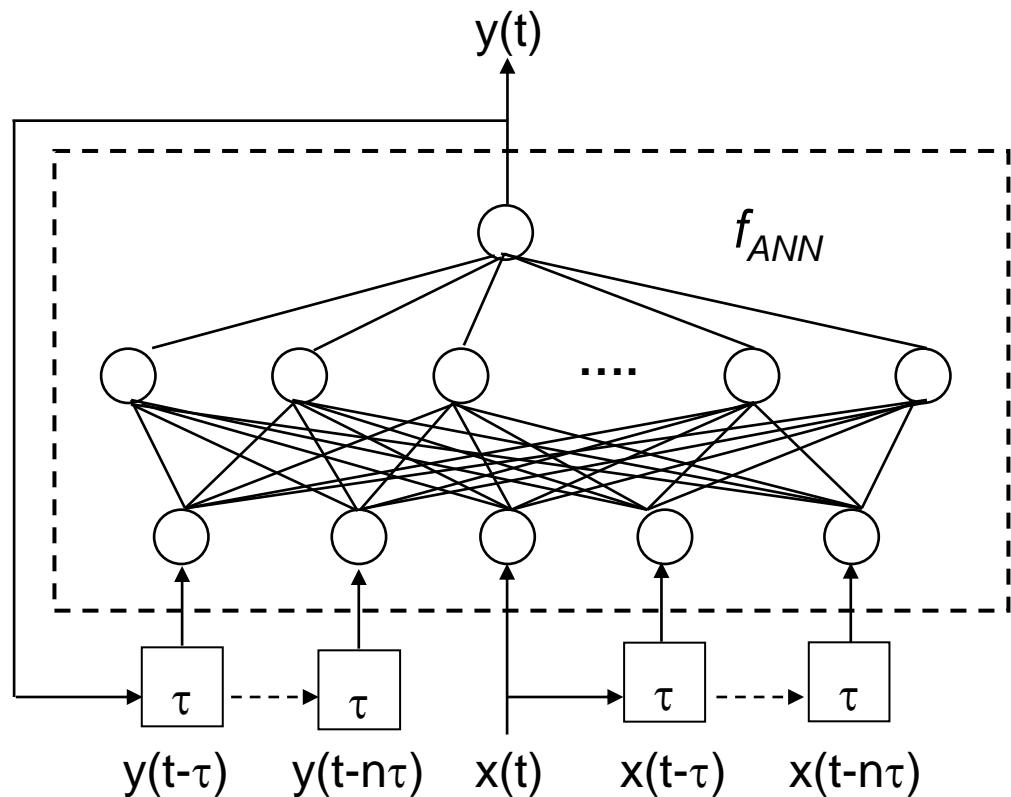
WJ FP2189 1W HFET

Model Validations
fund=2GHz, @Vd=8V,
Id=250mA, Pin=12dBm

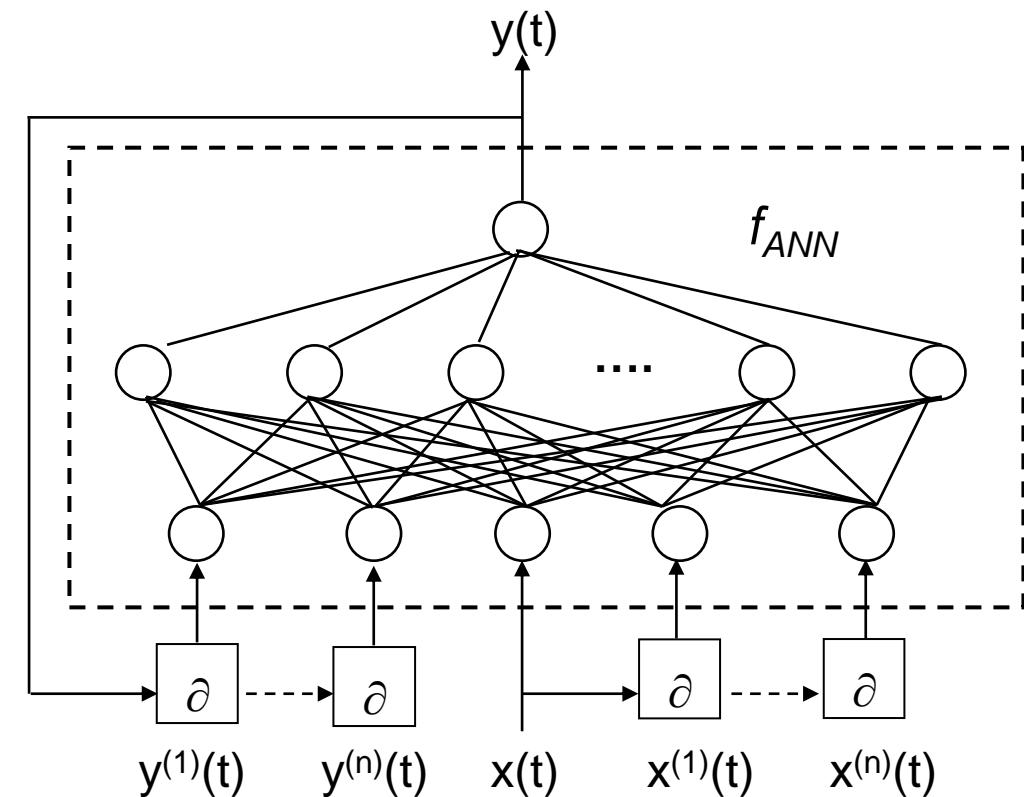
The results of unpublished
ANN-based X-parameter
model is virtually identical
to the table-based results
first published [8] shown
in these plots.



ANN for Time Domain Behavioral Modeling



Recurrent Neural Network (RNN)

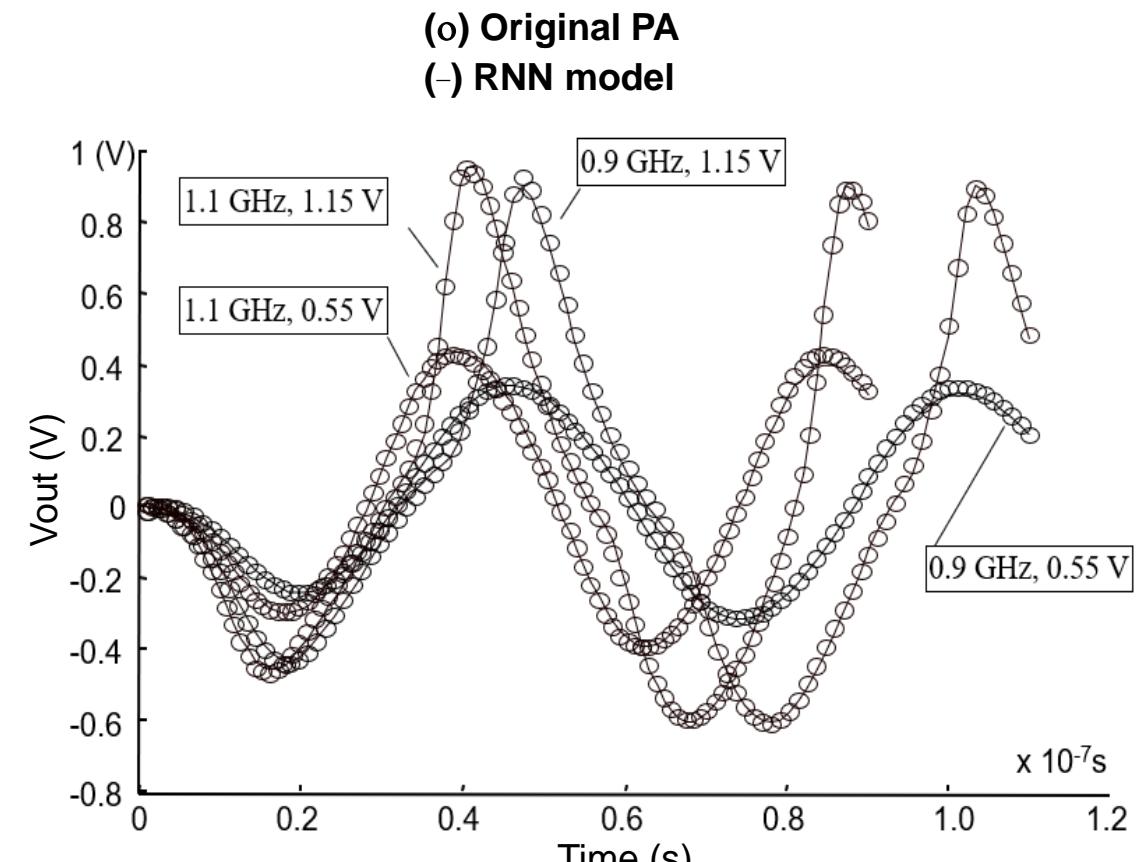
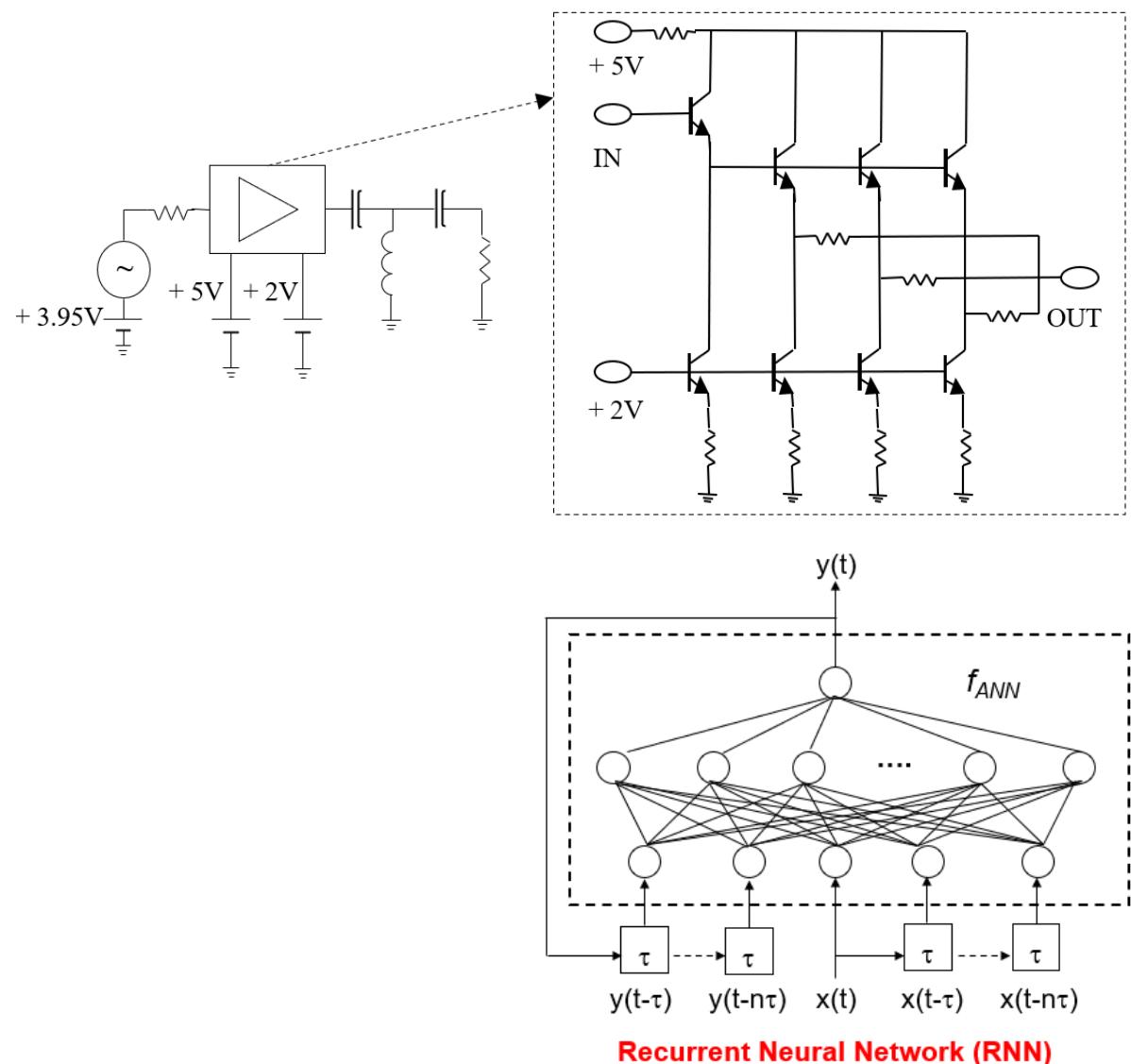


Dynamic Neural Network (DNN)

$$y(t) = f_{ANN}(y(t - \tau), \dots, y(t - n\tau), x(t), x(t - \tau), \dots, x(t - n\tau))$$

$$y(t) = f_{ANN}(y^{(1)}(t), \dots, y^{(n)}(t), x(t), x^{(1)}(t), \dots, x^{(n)}(t))$$

ANN for Time Domain Behavioral Modeling [7]



	RNN Model	Original PA
CPU Time for evaluation of 900 different sets of input–output waveforms	10 seconds	177 seconds

[7] Y.H. Fang et al, "A new macromodeling approach for nonlinear microwave circuits based on recurrent neural networks," *IEEE Trans. Microw. Theory Tech.*, vol. 48, pp. 2335–2344, Dec. 2000.

Outline

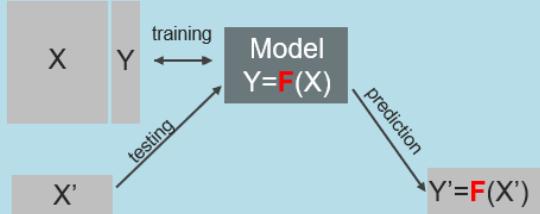
- **Introduction to AI, ML and ANN**
- **ANN for electronic device modeling**
- **ANN for electronic behavioral modeling**
- **Summary**

Summary

AI

ML

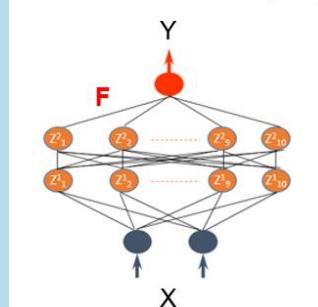
Supervised Learning



e.g.,

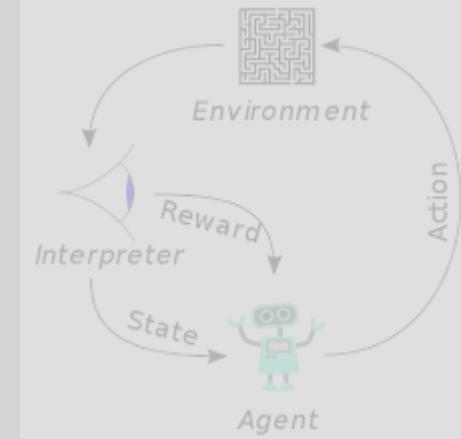
- Device modeling
- Device characterization
- Behavioral modeling

Artificial Neural Networks (ANN)

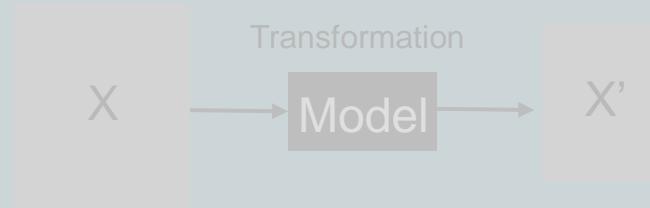


Reinforcement Learning

Model



Unsupervised Learning

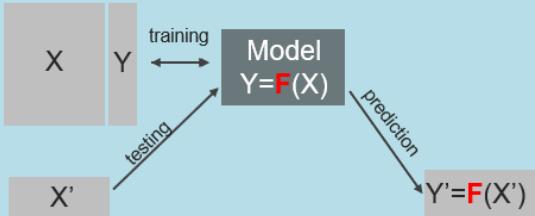


Summary

AI

ML

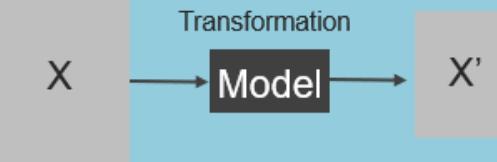
Supervised Learning



e.g.,

- Device modeling
- Device characterization
- Behavioral modeling

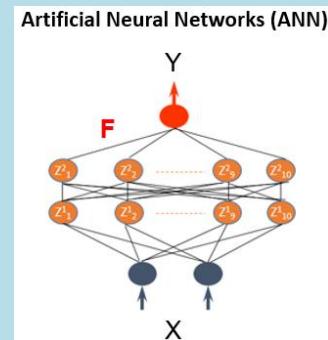
Unsupervised Learning



e.g.,

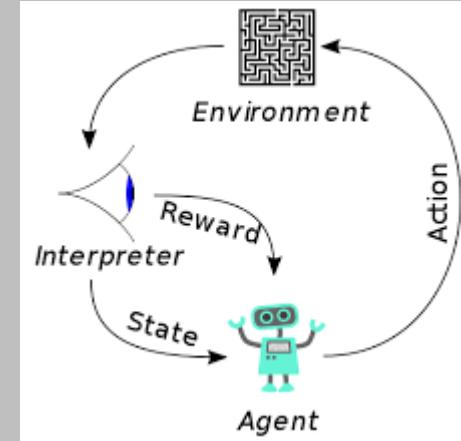
- Automatic Circuit Tuning

Automates the post-fabrication circuit tuning process



Reinforcement Learning

Model



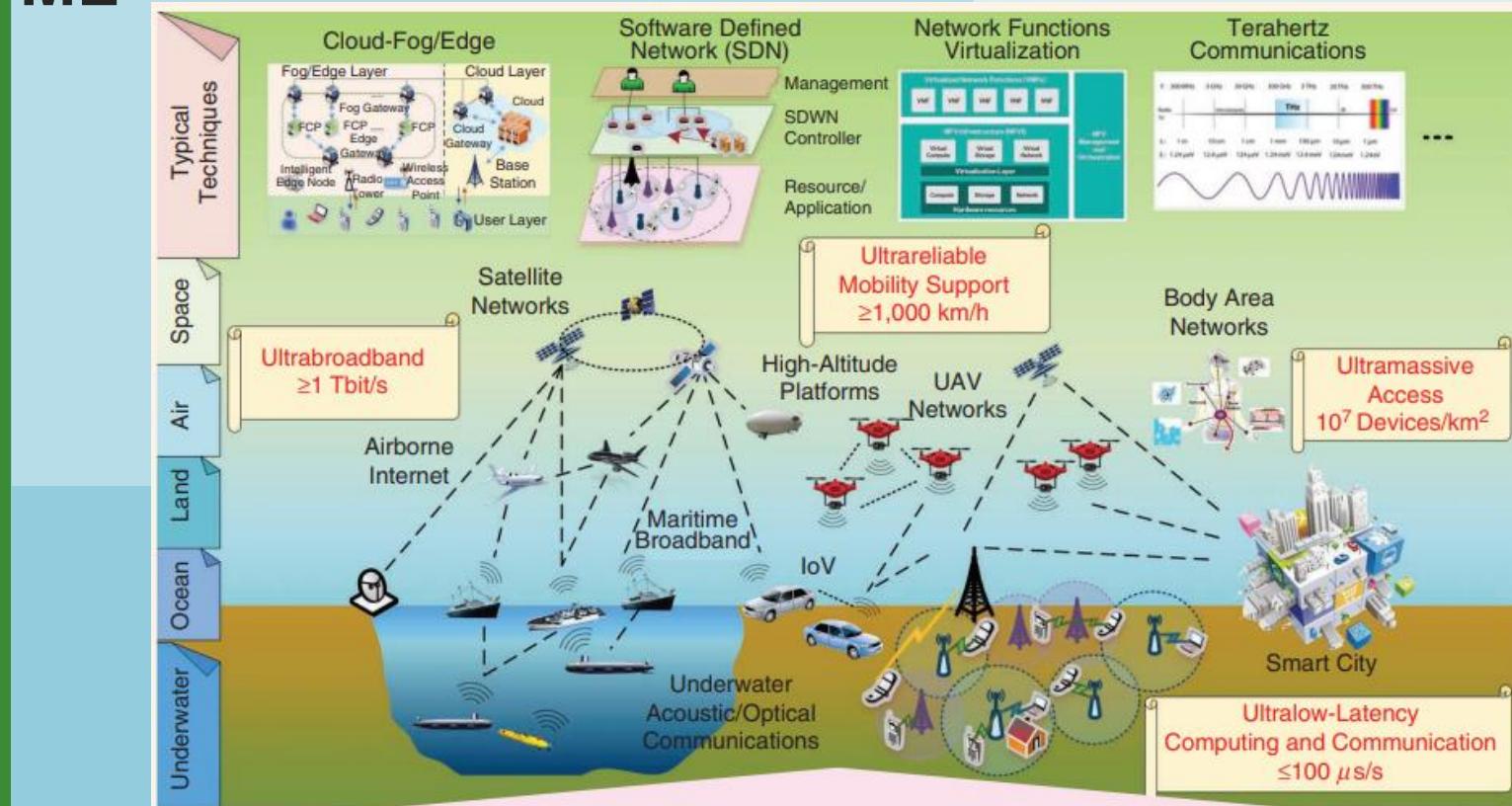
e.g.,

- Optimization and multi-physics
Exploration and exploitation for design problems with many variables

Future Potential

AI

ML



6G
Network
[8]

- Make more optimized and adaptive data-driven decisions
- Alleviate communication challenges
- Meet requirements from emerging services

[8] J. Du et al, "Machine Learning for 6G Wireless Networks: Carrying Forward Enhanced Bandwidth, Massive Access, and Ultrareliable/Low-Latency Service", *IEEE Vehicular Technology Magazine*, vol. 15, pp. 122-134, Dec. 2020.

Thank you!